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PCM-AIO
OPERATIONS MANUAL

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REVISION HISTORY

P/N 403-0172-000

ECO NUMBER	Date Code	Rev Level
ORIGINATED	032993	A
93-67	092493	A1
94-31	940817	A2
98-29	980414	A3
98-48	980723	B

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1 GENERAL INFORMATION

1.1 FEATURES

- Low cost, 12-bit A/D
- Up to 8 A/D input channels
- Each A/D channel configurable for Unipolar (0 to +5V) or Bipolar (-2.5 to +2.5V)
- Single-ended or Differential Input Modes
- Built-in Sample-and-Hold
- 100KHz sampling rate
- I/O mapped on the PC/104 Bus
- Processor independent
- Very low power, all CMOS components
- Two channel 12 Bit CMOS D/A converter
- Selectable UNIPOLAR or BIPOLAR voltage output for each channel
- Two output voltage ranges: 0 to 5V or -5V to +5V

1.2 GENERAL DESCRIPTION

1.2.1 PC/104 Bus Interface

The PCM-AIO is I/O port mapped with the unique port address determined by an on board EPAL decoder. The PCM-AIO uses a total of 8 I/O ports and is designed to work with standard NMOS/TTL or CMOS base boards.

1.2.2 Analog to Digital Converter

The PCM-AIO contains the Maxim MAX180, 12-bit data acquisition system. It combines an 8 channel input multiplexer, high bandwidth Track-and-Hold (T/H), low-drift zener reference, and flexible microprocessor interface with a high conversion speed, successive approximation analog to digital converter. The device samples and digitizes at a 100KHz throughput rate. The MAX180 can be software configured for unipolar or bipolar conversions and single-ended or differential inputs on a per channel basis. Output coding is natural binary for unipolar operation with 1 LSB = 1.22mV (5V/4096). Coding is twos complement for bipolar. Potentiometers are on the card to permit both gain and offset adjustment.

1.2.3 Starting an A/D conversion

The conversion is begun by writing a word to the control register to select the channel and specify if it is single-ended/differential and unipolar/bipolar. Output data is latched and the PCM-AIO signals the base board that conversion is complete and data is available. This board sets a Busy flag for use in a polled mode and can generate an interrupt after each completed conversion.

1.2.4 A/D Input Configuration

All input channel are wired to J1, a 26-pin right angle male connector. It has the same pin-out as WinSystems' MCM/LPM-A/D12. J1 is configured so that mass termination type flat ribbon cable or discreet wires can be connected to it. WinSystems offers the CBL-120-3 which is a 3 foot, #28 AWG, ribbon cable designed to provide access to signals from the 26-pin, 0.100 " grid connector on the PCM-AIO board. One end of the cable has a polarized, 26-pin female socket connector with strain relief that plugs into the board and the other end is open to allow users to make their own custom termination. The CBL-130-4 is a 4 foot, ribbon cable that will connect the PCM-AIO to the Analog-ADP. This board is a non-isolated signal conditioner and termination panel.

1.2.5 Digital to Analog Converter

The PCM-AIO has two 12 bit digital to analog convertor channels. Each channel can be configured for either a unipolar or bipolar output with one of two output ranges: 0 to 5V or +/-5V. The D/A section on the PCM-AIO takes 4 I/O ports.

1.2.6 D/A Operation

Each D/A channel on the PCM-AIO is reset to logic zero after a system reset. To output a digital word to a channel, the low byte is written to the low byte address (ALWAYS EVEN), the upper 4 bits of the 12 bit word is written to the next address (ALWAYS ODD). After writing the upper 4 bits, the channel is automatically updated. It is important to note that a channel is only updated when the upper 4 bits are written to the odd address.

EXAMPLE: 0 to 5V unipolar output selected
D/A Ports are located at 100-10B

To Output 800 HEX to channel 0 (should equal 2.5V output)

1. OutpuT 00 HEX TO I/O PORT 108 HEX
2. Output 08 HEX TO I/O PORT 109 HEX

When the 08 hex is written to I/O Port 101, the 12 bit word will be converted to a 2.5V output.

1.2.7 PC/104 Module

PC/104 multimodule boards are small (3.550" x 3.775"), I/O or memory mapped boards which plug into a base board. The PC/104 boards connect to the PC/104 bus connector and convert the PC/104 bus signals to a defined memory or I/O interface. The PC/104 is a unique design approach to Embedded Systems users offering a broad range of expansion boards joined together on the PC/104 interface. The PCM-AIO is designed to fit on all WinSystems' processors that have PC/104 connectors, our LPM/MCM-SX386/486, and other CPU base boards.

1.3 SPECIFICATIONS

1.3.1 Electrical

A/D

Number of Channels:	Up to 8
A/D Resolution:	12-bits
Input range:	0 to +5 volts; single-ended -2.5 to +2.5 volts; differetial
Coding:	Natural binary (unipolar) Two's complement (bipolar)
Nonlinearity:	1 LSB
Gain error:	Adjustable to zero
Conversion speed:	10 microseconds

D/A

Number of Channels:	2
D/A Resolution:	12-bits
Voltage Output:	0 to 5 VDC or -5 to +5 VDC
Output Drive:	2.5 mA

Power Requirements:

VCC	+5 VDC 5% at 35 mA (typ. outputs unloaded)
VCC1	-12VDC 10% at 15 mA (typ. outputs unloaded)
VCC2	+12VDC 10% at 15 mA (typ. outputs unloaded)

1.3.2 Mechanical

Dimensions:	3.550" x 3.775"
Connectors :	
	A/D Input: 26-pin dual pin on 0.100"
	D/A Output: 26-pin dual pin on 0.100"
	PC/104: 62-pin dual pin on 0.100"

1.3.3 Environmental

Operational Temperature:	0° C to +65° C

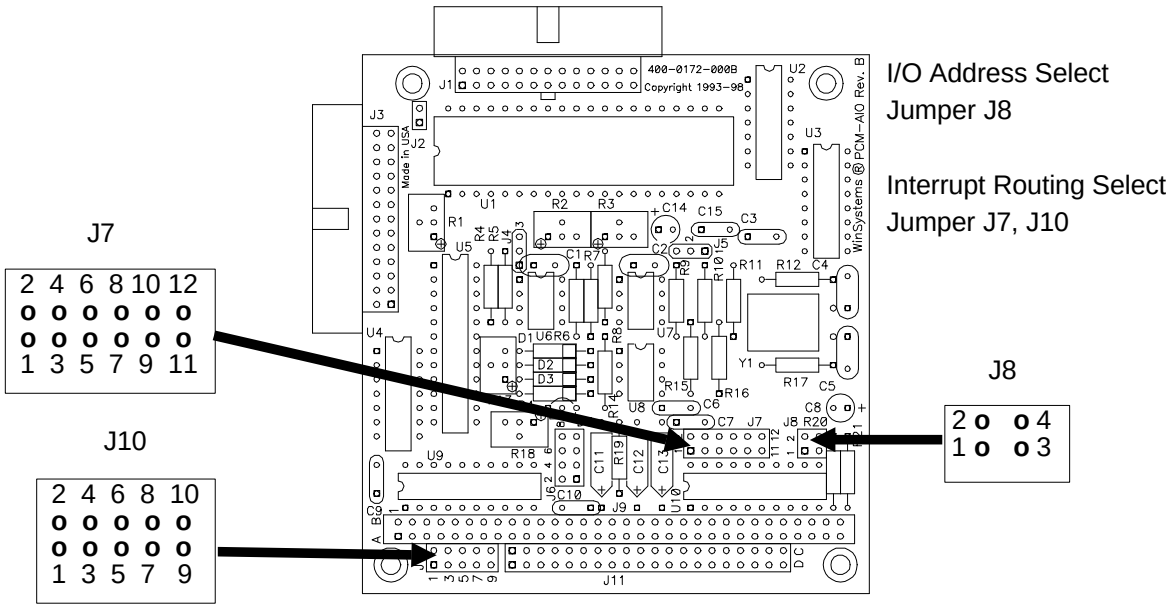
1.3.4 Ordering Information

PCM-AIO	12-bit A/D converter
CBL-120-3	3 ft., 26 conductor ribbon cable unterminated
CBL-130-4	4 ft., 26 conductor, ribbon cable to the Analog-ADP card
	Analog-ADP Analog termination panel

2 PCM-AIO Technical Reference

2.1 Introduction

This section of the manual is intended to provide sufficent information regarding the configuration, and programming of the PCM-AIO module. A complete reprint of the MAX 180 datasheet is provided in Appendix C for specific information on the chip. Questions not adequately addressed in this section should be addressed to the WinSystems Technical Support department at (817) 274-7553 between 8AM and 5PM Central time Monday through Friday.



2.2 I/O Address Select

The PCM-AIO decodes 16 I/O ports to access the board. The I/O port addresses are determined by an EPAL and is controlled by jumper block J8. The figures below show the Base I/O address as determined by the jumpering of J8.



2.3 A/D Registers

OFFSET 0 - Write

Bits 7-5	Unused
Bit 4	1 = Differential Input, 0 = Single Ended input
Bit 3	1 = Bipolar Input, 0 = Unipolar Input
Bits 2-0	Channel Select 0 to 7

OFFSET 0 - Read

Bits 7-0	LSB of converted data

OFFSET 1 - Read

Bits 7-4	Unused
Bits 3-0	Upper 4 Bits of converted data

OFFSET 4 - Read

Bit 7	1 = A/D Busy, 0 = Conversion complete
Bits 6-0	Unused

2.4 D/A Registers

OFFSET 8 - Write

Bits 7-0	Channel A LSB data

OFFSET 9 - Write

Bits 7-4	Unused
Bits 3-0	Channel A - Upper 4 bits of 12-Bit ouput value.

OFFSET 10 - Write

Bits 7-0	Channel B LSB data

OFFSET 11 - Write

Bits 7-4	Unused
Bits 3-0	Channel B - Upper 4 bits of 12-Bit ouput value.

2.5 Interrupt Routing Select

The PCM-AIO is capable of generating an interrupt on conversion complete from the MAX180. This interrupt may be routed to any of several PC/104 bus interrupts using the jumper block at J7 or J10. The jumpering detail for J7 and J10 is shown here :

J7

1 o	o 2	IRQ2
3 o	o 4	IRQ7
5 o	o 6	IRQ6
7 o	o 8	IRQ5
9 o	o 10	IIRQ4
11 o	o 12	IRQ3

J10

1 o	o 2	IRQ14
3 o	o 4	IRQ15
5 o	o 6	IRQ12
7 o	o 8	IRQ11
9 o	o 10	IRQ10

2.6 A/D Input Connector

The figure below shows the pinout for the PCM-AIO analog input connector J1 in both single-ended and differential modes.

J1

Channel 0	1 o o 14	Channel 1
Channel 2	2 o o 15	Channel 3
Ground	3 o o 16	Ground
Channel 4	4 o o 17	Channel 5
Ground	5 o o 18	Ground
Channel 6	6 o o 19	Channel 7
Ground	7 o o 20	Ground
Channel 1	8 o o 21	N/C
Ground	9 o o 22	Ground
Channel 3	10 o o 23	N/C
Ground	11 o o 24	Ground
Channel 5	12 o o 25	N/C
Channel 7	13 o o 26	N/C

J1 Input Pin Definitions - Single Ended Mode

J1

Channel 0 (+)	1 o o 14	Channel 0 (-)
Channel 2 (+)	2 o o 15	Channel 2 (-)
Ground	3 o o 16	Ground
Channel 4 (+)	4 o o 17	Channel 4 (-)
Ground	5 o o 18	Ground
Channel 6 (+)	6 o o 19	Channel 6 (-)
Ground	7 o o 20	Ground
Channel 0 (-)	8 o o 21	N/C
Ground	9 o o 22	Ground
Channel 2 (-)	10 o o 23	N/C
Ground	11 o o 24	Ground
Channel 4 (-)	12 o o 25	N/C
Channel 6 (-)	13 o o 26	N/C

J1 Input Pin Definitions - Differential Mode

2.7 Single Ended Operation

The PCM-AIO allows eight single ended inputs with a voltage input range of 0 to 5 VDC for unipolar operation or -2.5 to +2.5 VDC for bipolar operation. An input channel is selected as a single ended input by setting the SI bit to a '0' when writing the channel select/command word.

2.8 Differential Operation

The PCM-AIO allows up to 4 channels of differential operation. Each differential channel requires two inputs, i.e. a (+) input and a (-) input. The PCM-AIO can have a mixture of single ended and differential input signals by programming the appropriate channel se-

lect/convert to each channel. A channel is programmed for differential operation by writing a '1' to the DI bit in the channel/convert word. For proper operation a channel that is used as a differential with differential inputs should have a bias return for each input, i.e. (+) and (-). A one megohm resistor from each differential input to ground will provide a sufficient bias return path for each input.

Note: It is possible to reverse the + and - differential inputs in software for a given channel. See Table 1 of the MAX180 datasheet on page 7-94 in Appendix C.

2.9 Unipolar/Bipolar Operation

Each channel on the PCM-AIO can be operated in either unipolar or bipolar mode. A unipolar input provides a 0 to 5 VDC input while a bipolar input provides a -2.5 VDC to +2.5VDC input. A channel is programmed for unipolar if the BP bit in the channel select/convert bit is set to '0' and by programming the BP bit to a '1', the channel is set for bipolar operation.

2.10 A/D Software Interface

An A/D conversion is started by writing a byte to the channel select/convert byte located at I/O port location BASE + 0. The actual location of the PCM-AIO depends on the I/O address that is selected by jumper block J8. The byte written to the channel select/convert port will set the PCM-AIO for the selected channel, unipolar/bipolar, and single ended/differential operation and then begin a conversion. It is important to note that in this mode of operation, the MAX180 allows only 1.875 uS to acquire the signal. If the input source impedance is greater than 8 kOhms, then the Asynchronous Hold mode will need to be used in order to allow enough time to acquire the signal. The PCM-AIO will convert the analog voltage to digital data in approximately 10 uS. If desired, an end of conversion interrupt can be generated on the PC/104 and routed through J7 as shown earlier. The interrupt controller will need to be initialized to take advantage of this feature. Another way to determine if the conversion is completed is to poll the ST status bit in the STATUS READ I/O port located at BASE + 4. The ST status bit is the most significant bit (MSB). The ST bit will be high '1' when the A/D convertor is BUSY and low '0' when it is finished. See the MAX180 datasheet, page 7-95, Figure 7b in the Appendix C for timing.

If the input source impedance is greater than 8 kOhms, the Track and Hold circuit will not have enough time to acquire the signal and the conversion will not be correct. Under these conditions, the MAX180 A/D convertor will need to operated in the “Asynchronous Hold Mode”. See the MAX180 datasheet, page 7-98, Figure 10b in the Appendix C. The jumper J2 will need to be removed to place the MAX180 in the asynchronous mode. In the asynchronous mode it will be necessary to perform two write cycles to begin a conversion. The first write cycle is the same as before, except the channel data is written to an odd I/O port of BASE + 1. This will select the proper channel and select the mode of operation, however a conversion will not begin until the second write cycle is generated by writing the

same data to the I/O port BASE + 0. This mode is made available so that a variable time can be inserted between write cycles to allow the Track/Hold circuit to acquire the input signal.

2.11 A/D CALIBRATION PROCEDURE

The PCM-AIO is calibrated at the factory for the 0-5V range of operation. When switching to another input range, a slight adjustment may be necessary. The following procedure is given to calibrate the PCM-AIO for any input range.

2.11.1 CALIBRATION PROCEDURE

1. Select the desired mode and input voltage range. Use a software routine that will loop continuously on one channel.

2. OFFSET/ZERO ADJUSTMENT. (TRIMPOT R3)

Apply a voltage source between the selected analog channel and ground. A 1uF ceramic capacitor should be used across the inputs to suppress noise. Adjust the output of the voltage source to + 1/2 LSB. Adjust the offset/zero trimming potentiometer R3 so that the output code flickers equally between 000 HEX and 001 HEX for unipolar operation and 800 HEX and 801 HEX for the bipolar mode.

3. FULL SCALE ADJUSTMENT. (TRIMPOT R2)

Change the output of the voltage source for + FS-1 1/2 LSB. Adjust the gain trimming potentiometer R2 so that the output code flickers equally between FFE HEX and FFF HEX.

2.12 Output Coding

INPUT VOLTAGE RANGE		CODING
	UNIPOLAR	**STRAIGHT BINARY**
	0 TO +5V	**MSB LSB**
+FS	5.0000	1111 1111 1111
+FS-1LSB	4.9988	1111 1111 1110
+1LSB	0.0012	0000 0000 0001
ZERO	0.0000	0000 0000 0000
	BIPOLAR	**OFFSET BINARY**
	+/- 2.5V	**MSB LSB**
+FS	+2.5000	0111 1111 1111
+FS-1	+2.4988	0111 1111 1110
+1LSB	+0.0012	0000 0000 0001
ZERO	0.0000	0000 0000 0000
-1LSB	-0.0012	1111 1111 1111
-FS-1LSB	-2.4988	1000 0000 0001
-FS	-2.5000	1000 0000 0000

2.13 A/D SOFTWARE EXAMPLES

The following gives an example of an 8088/8086 assembly language routine that will interface to the PCM-AIO in synchronous polled mode for a 0 to 5 VDC, unipolar input range.

```
        mov  dx,BASE_PORT   ;Set PC/104 Base I/O Address
        mov  al,0           ;Chan 0, Single Ended, Unipolar
        out  dx,al          ;Start Conversion
        add  dx,4           ;Point to Status Register
wait:   in   al,dx          ;Read Status Bit
        test  al,80H        ;See if Conversion Finished
        jne  wait           ;If Not, Try Again
        mov  dx,BASE_PORT   ;Point to Low data Byte
        in  al,dx           ;Read Low Data Byte
        mov  bl,al          ;Save Low Byte
        inc  dx             ;Point to High Byte
        in  al,dx           ;Read High Byte
        mov  bh,al          ;Combine with Low Byte
        and  BX,0FFFH       ;BX=Conversion Data
```

The following program gives an example of a C program for performing A/D conversions with the PCM-AIO.

```
/*
                        PCM-AIO
    This program was written Primarily as a test/setup procedure
    for the PCM-AIO board. (400-0172-000)
    It also demonstrates how to access the MAX180 part,
    and shows various methods of accessing the part.
    Use getconv() for real-time readings in the foreground.
    Use the Interrupt driven method to provide an array image
    of all eight channels, constantly updated in the background.

    Date: 05-22-1992.
    Author: John Keller
    Copyright 1992 by WinSystems. All Rights Reserved.
*/

#include <stdio.h>
#include <dos.h>
#include <stdlib.h>
#include <graph.h>

void (_interrupt _far *OldTmr)(void);          /* Pointer to old ISR */
void (_interrupt _far *TmrPtr)(void);          /* Temporary ISR Pointer */
void interrupt Int1c(void);                    /* Declaration on ISR */

void (_interrupt _far *OldRq5)(void);          /* Pointer to old ISR */
void (_interrupt _far *Rq5Ptr)(void);          /* Temporary ISR Pointer */
void interrupt Int0d(void);                    /* Declaration on ISR */
unsigned int ticks[5],convi;
unsigned int tar[8] = {0x000,0x924,0x249,0xb6d,0x492,0xdb6,0x6db,0xfff};
main()
{
int a,b,c;
   for(a=0; a2;a++)
                        printf("                                \n");
   _settextposition(1,1);
   printf("Test for PCM-AIO boards\n");
   printf("     To set up the board, connect the Voltage Source to the points\n");
   printf(" indicated on the test fixture and set for 4.998 Volts.\n");
   printf(" Adjust R3 on A/D until channel 0 %'Read%' is switching between 0 & 1.\n");
   printf(" Next, Adjust R2 on A/D until channel 7 %'Read%' is FFE.\n");
   printf(" Increase to 5.000 Volts. Ch 7 %'Read%' should now be FFF. Ch 0 %'Read%' should\n");
   printf(" still be between 0 and 1.\n");
   printf(" All channels should display PASS. You should NOT see the messages\n");
   printf(" %'Interrupt Failed%', or %'Busy is Stuck%' below the channels.\n");

   OldRq5 = _dos_getvect(0x0d);
   OldTmr = _dos_getvect(0x1c);
   TmrPtr = Int1c;
   Rq5Ptr = Int0d;
   _dos_setvect(0x1c,TmrPtr);
   _dos_setvect(0x0d,Rq5Ptr);
```

```
_displaycursor(_GCURSOROFF);
   a = inp(0x21);
   a &= 0xdf;                                   /*unmask irq5 */
   outp(0x21,a);
   _settextposition(11,10);
   printf("Ch Trgt Read Difference");
   while(1)
   {
                  for(a=0; a; a++)          /* Scan all channels */
                  {
                     c=getconv(a,0);        /* Channel a, single ended, Unipolar */
                     _settextposition(a+12,10);
                     printf("%2d %3X %3X %3X",a,tar[a],c,abs(c-tar[a]));
                     if(c  tar[a])
                                            putch('-');
                     if(c  tar[a])
                                            putch('+');
                     if(c == tar[a])
                                            putch(' ');
                     printf(" %3d%% ",abs(c-tar[a]) / 41);
                     if(a 0 && a )
                     {
                                            If(abs(c-tar[a])()        /*1% resistors used for testing */
                                               printf("Pass");
                                            else
                                               printf("Fail");
                     }
                     if(a == 0 || a == 7)
                     {
                                            If(abs(c-tar[a]))         /*used for offset/gain calibration*/
                                               printf("Pass");
                                            else
                                               printf("Fail");
                     }
                  }
                  if(kbhit())
                     break;
   }
   a = inp(0x21);
   a |= 0x20;                                   /*mask irq5 */
   outp(0x21,a);
   _displaycursor(_GCURSORON);
   _dos_setvect(0x0d,OldRq5);
   _dos_setvect(0x1c,OldTmr);
}
/* Get conversion. */
/* MODE:
   0              Single ended, Unipolar.
   1              Single ended, Bipolar.
   2              Differential, Unipolar.
   3              Differential, Bipolar.
```

```
NOTE:
   In Differential mode, valid channels are still 0-7, however,
   the channels are paired, evens with odds. (I.E. 0 with 1, 2 with 3,
   etc.) The channel read becomes the “+” leg for the reading.
                        Example:
                           Channel 0 is 1.500 Volts lower than channel 1.
                           Mode is 2.
                           Channel read is 1.
                           Result: 1228(d) = 4CC(h).
                           If channel 0 had been read, the result would be zero.
*/
int getconv(int ch,int mode)
{
unsigned int a,b,c;
   convi=0;
   mode &= 3;
   outp(0x100,ch|(mode<< 3));
   ticks[0] = 2;
   while(ticks[0] && (inp(0x104) & 0x80));
   if(ticks[0] == 0)
   {
                        _settextposition(22,1);
                        printf(“Busy is stuck.\n”);
   }
   if(convi == 0)
   {
                        _settextposition(23,1);
                        printf(“Interrupt Failed\n”);
   }
   a = inp(0x100) & 255;
   b = inp(0x101) & 15;
   c = (b<8) | a;
   return(c);
}

/* Timer Tick Interrupt */
void interrupt Int1c(void)
{
int a;
   for(a=0; a; a++)
   {
                        if(ticks[a]  0)
                           ticks[a]—;
   }
}


/* A2D Interrupt from PC/104 */
void interrupt Int0d(void)
{
   convi++;             /* Used by test. */
```

```
/*                  SAMPLE APPLICATION */
/*                  Read All Eight Channels as Single/Uni & store in integer
                    Array variable results[8]. */

/*  read & store the result.*/
/*  result[channel] = inp(0x100) | ((inp(0x101)&15)<8);*/

/*  Start next conversion */
/*  ++channel &= 7;*/
/*  outp(0x100,channel);*/

   outp(0x20,0x20);                    /* Non-Specific EOI */
}
```

2.14 D/A Output Connector

J3

GND	1	2		Channel 0
N/C	3	4		GND
N/C	5	6		N/C
GND	7	8		Channel 1
N/C	9	10		GND
N/C	11	12		N/C
GND	13	14		N/C
N/C	15	16		GND
N/C	17	18		N/C
GND	19	20		N/C
N/C	21	22		GND
N/C	23	24		N/C
GND	25	26		GND

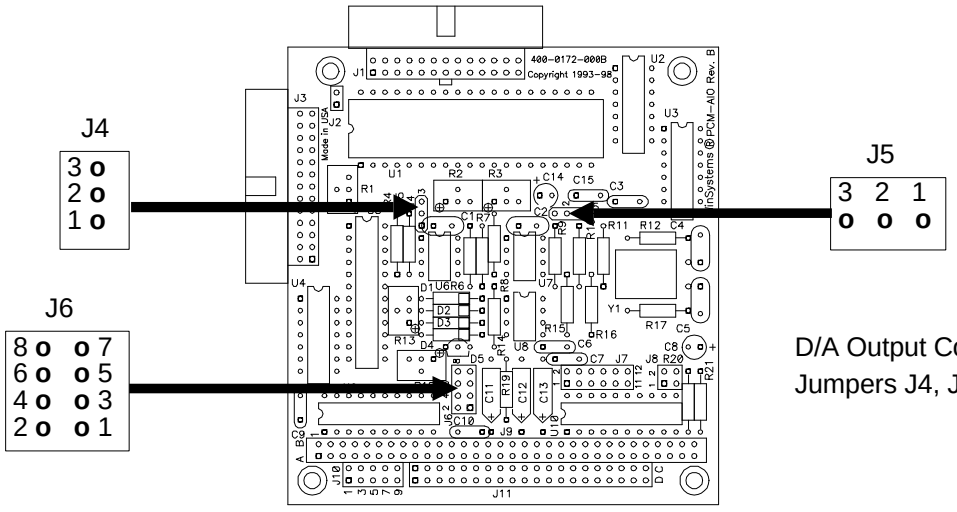
The figure below defines the pins on the D/A output connector J3.

2.15 D/A Voltage Reference and Output Selection

Each of the D/A channels on the PCM-AIO can be jumpered for either a +5VDC or -5VDC reference and for either unipolar or bipolar operation. The following chart shows the appropriate jumper positions for these options.

UNIPOLAR/BIPOLAR JUMPER SELECTION

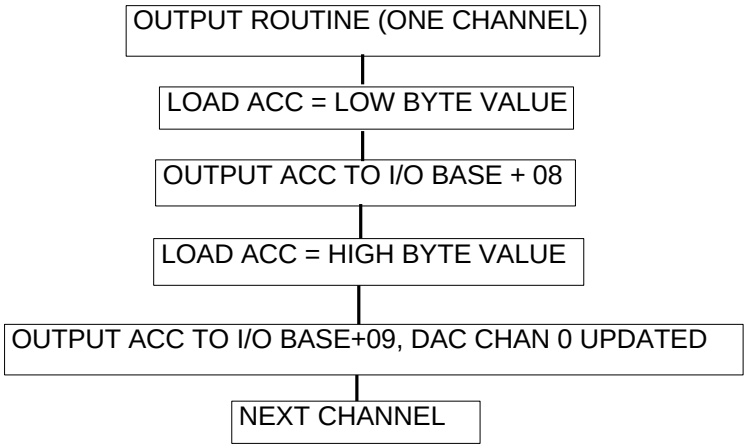
RANGE	CHANNEL 0	CHANNEL 1
0 to +5VDC	J6 3-4 J5 2-3	J6 7-8 J4 2-3
-5V to +5V	J6 1-2 J5 1-2	J6 5-6 J4 1-2



D/A Output Configuration
Jumpers J4, J5, J6

2.16 D/A Software Flowchart/Assembly Routine

8088/8086 ASSEMBLY LANGUAGE ROUTINE



8088/8086 ASSEMBLY LANGUAGE ROUTINE

```
MOV  DX,PORT_ADDRESS
MOV  AL,LOW_BYTE
OUT DX,AL
INC DX
MOV AL,HIGH_NIBBLE
OUT DX,AL
```

NOTE: The LOW_BYTE and HIGH_NIBBLE form the 12 bit data that is written to the D/A. The PORT_ADDRESS is the I/O address that is decoded on the selected PCM-AIO.

2.17 D/A CALIBRATION PROCEDURE

The D/A section of the PCM-AIO can be easily calibrated by the use of a digital voltmeter. To calibrate the D/A channels use the following procedure:

1. Install the board in the system and turn on the system to stabilize for at least 5 minutes.

2. Check the voltage reference output on J6 pin 1 for 5.000V. Adjust trimpot R13 if necessary.

3. Select the voltage reference output for each channel by the use of J6. See section 2.15.

4. For a unipolar output, output an 0FFF HEX to the channel or channels that are being calibrated and adjust the gain adjustment potentiometers for FS-1LSB as shown in the tables below.

5 .For a bipolar output, output an 0800 HEX to the channel or channels that are being calibrated and adjust the gain adjustment potentiometers for 0000 as shown in the tables below.

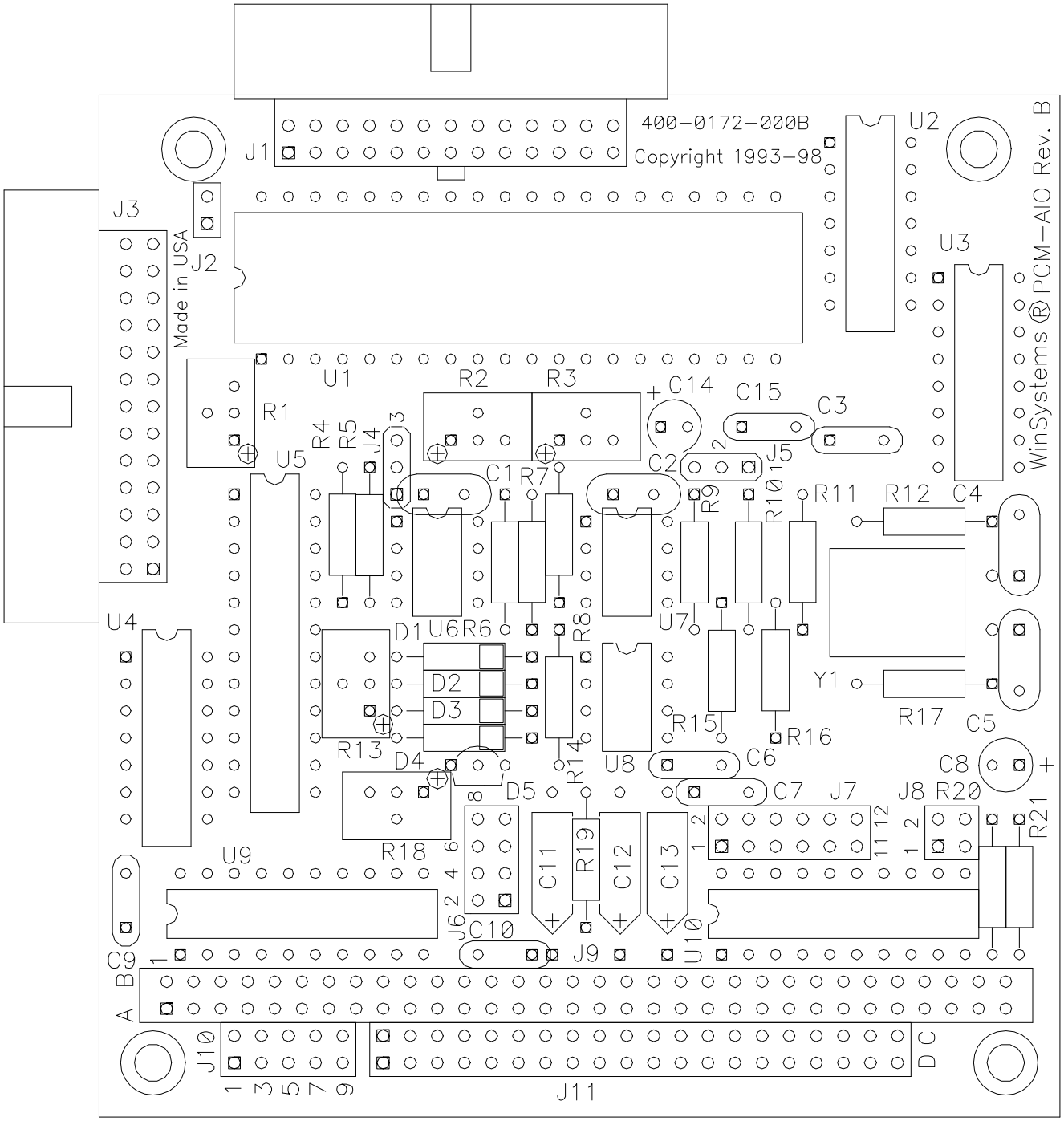
VOLTAGE OUTPUT FOR UNIPOLAR AND BIPOLAR RANGES

SCALE	**0 to +5V**	**-5V to +5V**
+FS-1 LSB	4.9988	4.9976
+1/2 FS	2.5000	0.0000

GAIN ADJUSTMENT POTENTIOMETERS VERSUS CHANNELS

CHANNEL	**POT**
0	R1
1	R18

3 APPENDIX A
PCM-AIO Parts Placement Guide



4 APPENDIX B
PCM-AIO Parts List

BEGINNING RANGE: PCM-AIO ENDING RANGE: PCM-AIO

LEVEL	ITEM KEY	ITEM DESCRIPTION	BOM DESCRIPTION	LOC	OVHD KEY	ITEM TYPE	QTY REQUIRED
1	PCM-AIO	PC/104 STACKTHROUGH 12-BIT ANALOG INPUT,					1
2	999-9999-001	SPECIAL NOTES	03-04-93 RC RELEASED	ARLIN		Inv	1
2	0172-100-0000	ASSY PCM-AIO REV A	ASSY PCM-AIO REV A	ARLIN		Inv	1
3	>999-9999-001	SPECIAL NOTES	04-03-95 MEB ECO#95-22	ARLIN		Inv	1
3	>999-9999-001	SPECIAL NOTES	03-04-93 RC RELEASED	ARLIN		Inv	1
3	>110-0001-001	CAP 22pF 100v 5% MICA RAD .234	C4,C5	ARLIN		Inv	2
3	>110-0003-001	CAP 56pF 12v 5% MICA RAD .141	C1,C2	ARLIN		Inv	2
3	>110-0010-003	CAP .1uF 50v 20% CER RAD .2	C3,C6,C7,C9,C10,C15	ARLIN		Inv	6
3	>110-0014-005	CAP 10uF 25v 10% TAN RAD .1	C8,C14	ARLIN		Inv	2
3	>110-0027-005	CAP 22uF 20v 10% TAN AX	C11-C13	ARLIN		Inv	3
3	>113-0101-102	POT 100 OHM 64WR100 (BI), RJ26FW	R1,R18	ARLIN		Inv	2
3	>113-0103-102	POT 10K 64WR10K (BI)	R13	ARLIN		Inv	1
3	>113-0104-102	POT 100K (BI) 64WR100K RJ26FW104	R2,R3	ARLIN		Inv	2
3	>114-0100-450	RESISTOR 10 OHM 1/4 5%	R19	ARLIN		Inv	1
3	>114-0102-450	RESISTOR 1K 1/4 5%	R12	ARLIN		Inv	1
3	>114-0103-450	RESISTOR 10K 1/4 5%, CR25 10k 5%	R20,R21	ARLIN		Inv	2
3	>114-0105-450	RESISTOR 1.0Meg 1/4 5%	R17	ARLIN		Inv	1
3	>124-0004-000	DIODE 1N4148	D1-D4	ARLIN		Inv	4
3	>134-2491-410	RESISTOR 2.49K 1% 1/4	R15	ARLIN		Inv	1
3	>134-4750-410	RESISTOR 47.5 OHM 1% 1/4W MF	R4,R8	ARLIN		Inv	2
3	>144-1002-401	RESISTOR 10.0K .1% 1/4W MF	R5,R9,R14,R16	ARLIN		Inv	4
3	>144-2002-401	RESISTOR 20.0K .1% 1/4W 50ppm MF	R6,R7,R10,R11	ARLIN		Inv	4
3	>200-0064-100	SCKT 64 POS STK ES1-64-12-2-GF (	J9 CLIP PIN B10, MUST BE HAND SOLDERED	ARLIN		Inv	1
3	>200-0203-100	SOCKET 20 PIN ICO-203-S8A-T (176	U10	ARLIN		Inv	1
3	>200-0243-100	SOCKET 24 P .3 ICO-243-S8A-T (14	U5	ARLIN		Inv	1
3	>200-0406-100	SOCKET 40 P .6 ICO-406-S8A-T (60	U1	ARLIN		Inv	1
3	>201-0026-121	HDR 26 P RA IDH-26LP-SR3-TG/TR (	J1,J3	ARLIN		Inv	2
3	>201-0036-010	HDR 1X36 UN TSW-136-07-G-S (SAM)	J2=2X1, J4,J5=1X3	ARLIN		Inv	.222
3	>201-0072-120	HDR 2X36 UN TSW-136-07-G-D	J6=2X4, J7=2X6, J8=2X2	ARLIN		Inv	.375
3	>220-0044-000	XTAL 6.4000 U49-15-64	Y1 USE FOAM TAPE UNDER XTAL	ARLIN		Inv	1
3	>400-0172-000B	PCB, PCM-AIO REV B	PCB, PCM-AIO REV B	ARLIN		Inv	1
3	>730-0004-000	IC, LM336BZ-5.0 (NAT) [100]	D5	ARLIN		Inv	1
3	>730-0008-000	IC, AD712JN, LT1057CN8	U6-U8	ARLIN		Inv	3
3	>741-0074-200	IC, 74HC74	U2	ARLIN		Inv	1
3	>741-0368-200	IC, 74HC368	U3	ARLIN		Inv	1
3	>745-0032-200	IC, 74HCT32	U4	ARLIN		Inv	1
3	>745-0245-200	IC, 74HCT245	U9	ARLIN		Inv	1
3	>999-9999-001	SPECIAL NOTES	MASK HOLES FOR J10,J11	ARLIN		Inv	1
2	0172-300-0000	SUB ASSY PCM-AIO REV A	SUB ASSY PCM-AIO REV A	ARLIN		Inv	1
3	>999-9999-001	SPECIAL NOTES	03-04-93 RC RELEASED	ARLIN		Inv	1
3	>901-0002-000	IC, EP320IPI-40 ALTERA (18)	U10 CS=6E5C	ARLIN		Inv	1
3	>730-0065-000	IC, MAX180-BCPL (10)	U1	ARLIN		Inv	1
3	>730-0010-000	IC, AD7537JN	U5	ARLIN		Inv	1
3	>KIT-PCM-STANDOFF-2	PC/104 STANDOFF KIT CONSISTING O	*DO NOT SEND FOR ASSEMBLY	ARLIN		Inv	1
4	>999-9999-001	SPECIAL NOTES	04-28-95 MEB (NEW BOM)	ARLIN		Inv	1
4	>500-0200-091	SPACER M/F RAF 4000-440-N-MODL.6	SPACER M/F RAF 4000-440-N-MODL.600	ARLIN		Inv	2
4	>500-0200-033	SCREW PPH 4-40 X 1/4"	SCREW PPH 4-40 X 1/4"	ARLIN		Inv	2
4	>500-0200-092	NUT HEX NYLON 4-40	NUT HEX NYLON 4-40	ARLIN		Inv	2
4	>525-0304-001	SIZE 3 COIN ENVLPE 2.5" X 4.25"	SIZE 3 COIN ENVELOPE 2 1/2 X 4 1/4	ARLIN		Inv	1
3	>201-0002-000	PLUG JUMPER 999-19-310-00	J2=1-2 J4=2-3 J5=2-3 J6=3-4 7-8	ARLIN		Inv	8
3	>999-9999-001	SPECIAL NOTES	J7=7-8 J8=1-2 3-4	ARLIN		Inv	1
2	950-0001-000	BAG STATIC BARRIER 07-0610 6X10	BAG ANTISTATIC 6X10 SC420610	ARLIN		Inv	1
2	910-0024-000	LABEL, STATIC SENSITIVE 130-02	APPLY TO ANTI-STATIC BAG TO SEAL	ARLIN		Inv	1
2	525-0304-001	SIZE 3 COIN ENVLPE 2.5" X 4.25"	SIZE 3 COIN ENVELOPE 2 1/2 X 4 1/4	ARLIN		Inv	1

REPORT RECAP

0 WARNING(S) * Indicates no BOM Found for Item
0 ERROR(S)

REPORT PARAMETERS

ASSEMBLY RANGE : PCM-AIO to PCM-AIO
TYPE : RWF

COMPONENT RANGE : <FIRST> to <LAST>
TYPE : RWF

MASKING : Inv-Explode Specific Inv Items (No Masks)

QUANTITY (TO EXPLODE): 1

DESC LENGTH: ITEM : 32
COMMENT : 40
LOCATION: 0
OVERHEAD: 0

NESTING INDENT LENGTH: 20

TOTAL REPORT WIDTH : 132

5 APPENDIX C
MAX180 DATASHEET REPRINT

19-3950, Rev 0; 6/91

MAXIM

Complete, 8-Channel, 12-Bit Data-Acquisition Systems

General Description

The MAX180/MAX181 are complete 12-bit Data Acquisition System (DAS) which combine 8/6-channel input multiplexer, high bandwidth Track-and-Hold (T/H), low-drift zener reference, and flexible microprocessor (µP) interface with high conversion speed and low power consumption. The MAX180/MAX181 can be configured by a µP for unipolar or bipolar conversions and single-ended or differential inputs. Both devices sample and digitize at 100kHz throughput rate and feature a fast 8- or 16-bit µP interface.

The MAX180 has 8 analog input channels, while the MAX181 has 6. The multiplexer output of the MAX180 is fed directly into the Analog-to-Digital Converter (ADC) input. The MAX181 brings out both the multiplexer output and ADC input to separate pins, allowing a programmable gain amplifier to be inserted between the MUX and the ADC.

The systems allow the user to choose between an internal or an external reference. Futhermore, the internal reference value and the offset can be adjusted, allowing the overall system gain and offset errors to be nulled. The multiplexer has high impedance inputs, simplifying analog drive requirements.

Applications

High-Speed Servo Loops

Digital-Signal Processing

High-Accuracy Process Control

Automatic Testing Systems

Features

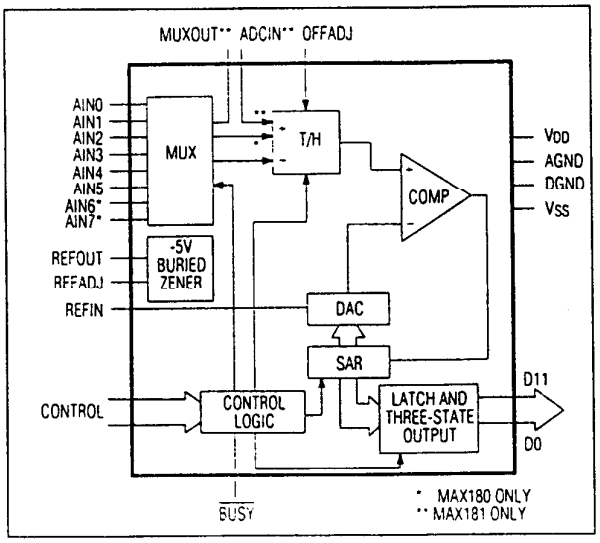
- ♦ 12-Bit Resolution, ±1/2LSB Linearity
- ♦ 8-Channel Multiplexed Inputs (MAX180)
- ♦ Single-Ended 1-of-6 Multiplexer (MAX181)
- ♦ Built-In Track-and-Hold
- ♦ 100kHz Sampling Rate
- ♦ DC and Dynamically Tested
- ♦ Internal 25ppm/°C Voltage Reference
- ♦ Each Channel Configurable for Unipolar (0V to +5V) or Bipolar (-2.5V to +2.5V) Input Range
- ♦ Each Channel Configurable for Single-Ended or Differential Inputs
- ♦ Fast 8-/16-Bit µP Interface
- ♦ +5V and -12V to -15V Supply Operation
- ♦ 110mW Power Consumption

Ordering Information

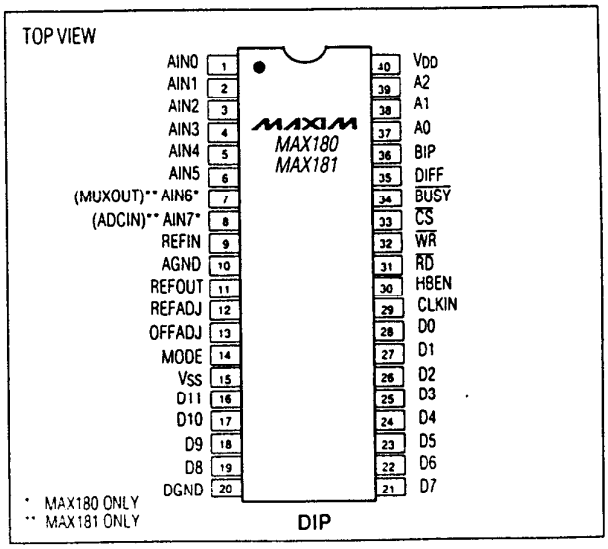
PART	TEMP. RANGE	PIN-PACKAGE	ERROR (LSBs)
MAX180ACPL	0°C to +70°C	40 Plastic DIP	±1/2
MAX180BCPL	0°C to +70°C	40 Plastic DIP	±1
MAX180CCPL	0°C to +70°C	40 Plastic DIP	±1
MAX180ACQH	0°C to +70°C	44 PLCC	±1/2
MAX180BCQH	0°C to +70°C	44 PLCC	±1

Ordering information continued on last page.

Block Diagram



Pin Configurations



MAXIM is a registered trademark of Maxim Integrated Products.

Complete, 8-Channel, 12-Bit Data-Acquisition Systems

ABSOLUTE MAXIMUM RATINGS

V_{DD} to DGND ..... -0.3V, +7V
V_{SS} to DGND ..... -0.3V, -17V
AGND to DGND ..... -0.3V, V_{DD} + 0.3V
AIN _, MUXOUT, ADCIN, REFADJ, OFFADJ to REFIN ..... -0.3V, V_{DD} + 0.3V
REFIN to DGND ..... +0.3V, V_{SS} - 0.3V
CS, WR, RD, CLK, A2-A0, BIP, DIFF, HBEN to DGND ..... -0.3V, V_{DD} + 0.3V
BUSY, D0-D11 to DGND ..... -0.3V, V_{DD} + 0.3V

Continuous Power Dissipation (any package)
to +70°C 1000mW
derates above +70°C by ..... 10mW/°C
Operating Temperature Ranges:
MAX18 _C _ _ ..... 0°C to +70°C
MAX18 _E _ _ ..... -40°C to +85°C
MAX18 _MJL ..... -55°C to +125°C
Storage Temperature Range ..... -65°C to +160°C
Lead Temperature (soldering, 10 sec) ..... +300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

(V_{DD} = +5V ±5%, V_{SS} = -12V ±5% or -15V ±5%, REFIN = -5V, Internal Reference Mode, Bipolar Mode, Slow-Memory Mode (see text), f_{CLK} = 1.6MHz external, MAX180/MAX181 all grades, T_A = T_{MIN} to T_{MAX}, unless otherwise noted.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
ACCURACY (Note 2)						
Resolution	N		12			Bits
Integral Nonlinearity Error	INL	MAX18_A			±1/2	LSB
		MAX18_B/C			±1	
Differential Nonlinearity Error	DNL	Guaranteed monotonic over temperature			±1	LSB
Unipolar Offset Error (Note 3)				±1	±4	LSB
Bipolar Offset Error (Note 3)				±1	±6	LSB
Unipolar Gain Error				±2	±10	LSB
Bipolar Gain Errror				±2	±15	LSB
Gain-Error Tempco (Note 4)				±5		ppm/°C
Channel-to-Channel Matching				±1/4		LSB
DYNAMIC PERFORMANCE (Note 2)						
Signal-to-Noise + Distortion Ratio	SINAD	10kHz input signal, 100kHz sampling rate, bipolar mode, T_A = +25°C	70			dB
Total Harmonic Distortion (up to the 5th harmonic)	THD	10kHz input signal, 100kHz sampling rate, bipolar mode, T_A = +25°C			-80	dB
Spurious-Free Dynamic Range	SFDR	10kHz input signal, 100kHz sampling rate, bipolar mode, T_A = +25°C	80			dB
Full-Power Sampling Bandwidth		In track mode, under-sampled waveform		6		MHz
Track-and-Hold Acquisition Time (Note 5)	t_{ACQ}		1.875			µs
Conversion Time	t_{CONV}	Asynchronous hold mode; Note 5	7.500		8.125	µs
		ROM, Slow-Memory, and I/O Port Modes; 15-16 clock cycles	9.375		10.000	
ANALOG INPUT						
Voltage Range		AIN_, MUXOUT, and ADCIN	REFIN		V_{DD}	V
Unipolar, Single-Ended Range		AIN_ to AGND	0		5.0	
Unipolar, Differential Range		AIN_+ to AIN_-	0		5.0	
Bipolar, Single-Ended Range		AIN_ to AGND	-2.5		2.5	
Bipolar, Differential Range		AIN_+ to AIN_-	-2.5		2.5	

ELECTRICAL CHARACTERISTICS (continued)

(V_{DD} = +5V ±5%, V_{SS} = -12V ±5% or -15V ±5%, REFIN = -5V, Internal Reference Mode, Bipolar Mode, Slow-Memory Mode (see text), f_{CLK} = 1.6MHz external, MAX180/MAX181 all grades, T_A = T_{MIN} to T_{MAX}, unless otherwise noted.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
ANALOG INPUT (continued)							
Input Current		AIN_, MAX180				±1.0	µA
		ADCIN, MAX181				±0.1	
Mux-On Resistance	R_{ON}	AIN_ = 2.5V, I_{MUXOUT} = 1.25mA, MAX181				2	kΩ
Mux-On Leakage Current	I_{ON}	AIN_ = MUXOUT = ±5V, MAX181				±100	nA
Mux-Off Leakage Current	$I_{IN (OFF)}$	AIN_ = ±5V, V_{OUT} = ±5V, MAX181				±100	nA
	$I_{OUT (OFF)}$	AIN_ = ±5V, V_{OUT} = ±5V, MAX181				±100	
Input Capacitance (Note 5)	C_{IN}	AIN_, ADCIN			25	35	pF
		MUXOUT			35	45	
REFERENCE INPUT							
Input Range (Note 5)				-4.92	-5.00	-5.08	V
Input Current						-2	mA
Input Resistance				2.5			kΩ
REFERENCE OUTPUT							
VREF Output Voltage		T_A = +25°C		-4.98	-5.00	-5.02	V
VREF Output Tempco (Note 6)		MAX18_A/B				25	ppm/°C
		MAX18_C				45	
VREF Load Regulation (Note 7)		I_{OUT} = 0mA to 5mA, T_A = +25°C			0.2	1.0	mV/mA
REFADJ, OFFADJ							
Input Current		V_{REFADJ}, V_{OFFADJ} = V_{DD} to REFIN				±1	µA
Disable Threshold				4.5			V
REFADJ Adjustment Range		REFIN < REFADJ <AGND		±60	±80		mV
OFFADJ Adjustment Range		REFIN < OFFADJ <AGND		±15	±25		LSB
LOGIC INPUTS							
Input Low Voltage	V_{IL}	MODE				0.5	V
		$\overline{CS}$, $\overline{RD}$, $\overline{WR}$, CLK, A2-A0, DIFF, BIP, HBEN				0.8	
Input High Voltage	V_{IH}	MODE		4.5			V
		$\overline{CS}$, $\overline{RD}$, $\overline{WR}$, CLK, A2-A0, DIFF, BIP, HBEN		2.4			
Input Mid-Level Voltage	V_{MID}	MODE		1.5		3.5	V
Input Floating Voltage	V_{FLT}	MODE			2.5		V
Input Current	I_{IN}	MODE	T_A = +25°C		±50	±100	µA
			T_A = T_{MIN} to T_{MAX}		±50	±100	
		$\overline{CS}$, $\overline{RD}$, $\overline{WR}$, CLK, A2-A0, DIFF, BIP, HBEN	T_A = +25°C			±1	
			T_A = T_{MIN} to T_{MAX}			±10	
Input Capacitance (Note 5)	C_{IN}					15	pF
LOGIC OUTPUTS							
Output Low Voltage	V_{OL}	D11-D0, $\overline{BUSY}$, RDY, I_{SINK} = 1.6mA				0.4	V
Output High Voltage	V_{OH}	D11-D0, $\overline{BUSY}$, RDY, I_{SOURCE} = 360µA		4.0			V
Floating State Leakage Current	I_{LKG}	D11-D0, V_{OUT} = 0V to V_{DD}				±10	µA
Floating State Output Capacitance (Note 5)	C_{OUT}					15	pF

Complete, 8-Channel, 12-Bit Data-Acquisition Systems

ELECTRICAL CHARACTERISTICS (continued)

(V_{DD} = +5V ±5%, V_{SS} = -12V +5% or -15V ±5%, REFIN = -5V, Internal Reference Mode, Bipolar Mode, Slow-Memory Mode (see text), f_{CLK} = 1.6MHz external, MAX180/MAX181 all grades, T_A = T_{MIN} to T_{MAX}, unless otherwise noted.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
POWER REQUIREMENTS						
Supply Voltage (Note 1)	V_{DD}		4.75	5.00	5.25	V
	V_{SS}		-11.40		-15.75	
Supply Current	I_{DD}	V_{DD} = 5V		4.5	7.0	mA
	I_{SS}	V_{SS} = -12V		7.0	10.0	
Power Dissipation	PD	V_{DD} = 5V, VSS = -15V		110	155	mW
Power-Supply Rejection, with Internal Reference	PSR	Input near FS, V_{SS} = -12V, V_{DD} = 4.75V to 5.25V		±1/2	±1	LSB
		Input near FS, V_{DD} = 5V, V_{SS} = -14.25V to -15.75V		±1/8	±1/2	
		Input near FS, V_{DD} = 5V, V_{SS} = -11.4V to = -12.6V		±1/8	±1/2	

TIMING CHARACTERISTICS

(V_{DD} = +5V, V_{SS} = -12V, f_{CLK} = 1.6MHz, Internal Reference Mode, T_A = T_{MIN} to T_{MAX}, unless otherwise noted.) (Note 8)

PARAMETER	SYMBOL	CONDITIONS	T_A = +25°C			MAX18_C/E			MAX18_M			UNITS
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	
$\overline{CS}$ to $\overline{RD}$ Setup time	t_1	Note 5	0			0			0			ns
$\overline{CS}$ to $\overline{RD}$ Hold time	t_2		0			0			0			ns
$\overline{CS}$ to $\overline{WR}$ Setup time	t_3		0			0			0			ns
$\overline{CS}$ to $\overline{WR}$ Hold time	t_4	Note 5	0			0			0			ns
$\overline{WR}$ Low Pulse Width	t_5		120			120			120			ns
$\overline{WR}$ High Pulse Width	t_6	MODE = 0 or 1; Note 5	200			200			200			ns
DATA IN to $\overline{WR}$ Setup Time	t_7		80			100			120			ns
DATA IN to $\overline{WR}$ Hold Time	t_8		0			0			0			ns
$\overline{WR}$ Rising to $\overline{BUSY}$ Delay	t_9	C_L = 50pF, MODE = 1			160			180			200	ns
$\overline{WR}$ Falling to $\overline{BUSY}$ Delay	t_{10}	C_L = 50pF, MODE = open			220			260			280	ns
$\overline{RD}$ Low Pulse Width	t_{11}		100			130			150			ns
$\overline{RD}$ High Pulse Width	t_{12}	Note 5	200			200			200			ns
DATA IN to $\overline{RD}$ Setup Time	t_{13}		80			100			120			ns
DATA IN to $\overline{RD}$ Hold Time	t_{14}		0			0			0			ns
$\overline{RD}$ to $\overline{BUSY}$ Fall Delay	t_{15}	C_L = 50pF			150			170			200	ns
$\overline{RD}$ to Data out Valid	t_{16}	C_L = 100pF; Note 9		50	100			130			150	ns
$\overline{RD}$ to Data out Three-State	t_{17}	Notes 9, 10		30	50			65			75	ns
HBEN to $\overline{RD}$ or $\overline{WR}$ Setup Time	t_{18}		80			100			120			ns
HBEN to $\overline{RD}$ or $\overline{WR}$ Hold Time	t_{19}		0			0			0			ns
$\overline{CS}$ to $\overline{READY}$ Fall Delay	t_{20}	C_L = 50pF			110			130			150	ns

TIMING CHARACTERISTICS (continued)

(V_{DD} = +5V, V_{SS} = -12V, f_{CLK} = 1.6MHz, Internal Reference Mode, T_A = T_{MIN} to T_{MAX}, unless otherwise noted.) (Note 8)

PARAMETER	SYMBOL	CONDITIONS		T_A = +25°C MIN	T_A = +25°C TYP	T_A = +25°C MAX	MAX18_C/E MIN	MAX18_C/E TYP	MAX18_C/E MAX	MAX18_M MIN	MAX18_M TYP	MAX18_M MAX	UNITS
$\overline{BUSY}$ to Data Out Valid	t_{21}	C_L = 100pF	Note 9			125			150			170	ns
$\overline{CS}$, $\overline{RD}$, or $\overline{WR}$ to CLK Setup time for 15 clock conversion	t_{22}		Note 5	220			220			220			ns
$\overline{CS}$, $\overline{RD}$, or $\overline{WR}$ to CLK Setup time for 16 clock conversion	t_{23}		Note 5	0			0			0			ns

Note 1: Performance at power-supply tolerance limits guaranteed by power-supply rejection test.
Note 2: V_{DD} = +5V, V_{SS} = -15V, FS = +5V, REFIN = -5V.
Note 3: Typical change over temperature is ±1LSB.
Note 4: FS Tempco = ΔFS/ΔT, where ΔFS is full-scale change from T_A = +25°C to T_{MIN} or to T_{MAX}.
Note 5: Guaranteed by design.
Note 6: REFIN TC = ΔREFIN/ΔT, where ΔREFIN is reference voltage change from T_A = +25°C to T_{MIN} or to T_{MAX}
Note 7: Load current should remain constant during conversion. This current is in addition to the DAC input current.
Note 8: All inputs are 0V to +5V swing with t_r = t_f = 5ns (10% to 90% of 5V) and timed from a voltage level of +1.6V.
Note 9: t_{16} and t_{21} are measured with the load circuits of Figure 1 and defined as the time required for an output to cross 0.8V or 2.4V.
Note 10: t_{17} is defined as the time required for the data lines to change 0.5V when the circuit load is as shown in Figure 2.

Pin Description

NAME	MAX180 DIP	MAX180 PLCC	MAX181 DIP	MAX181 PLCC	FUNCTION
AIN0-AIN5	1-6	2-7	1-6	2-7	Analog Inputs to the mux: 0V to +5V unipolar, -2.5V to +2.5V bipolar
AIN6-AIN7	7,8	8,9			Analog Inputs to the mux: 0V to +5V unipolar, -2.5V to +2.5V bipolar
MUXOUT			7	8	Muliplexer Output
ADCIN			8	9	Analog Input to track-and-hold
REFIN	9	10	9	10	Reference Input
AGND	10	11	10	11	Analog Ground
REFOUT	11	13	11	13	-5V Reference Output
REFADJ	12	14	12	14	-5V Reference Adjust. Connect to V_{DD} if not required.
OFFADJ	13	15	13	15	Offset Adjust. Connect to V_{DD} if not required.
MODE	14	16	14	16	Interface Mode Select pin.
V_{SS}	15	17	15	17	Negative Supply: -15V or -12V
D11-D8	16-19	18-21	16-19	18-21	Three-State Data Outputs, MSB = D11
DGND	20	22	20	22	Digital Ground
D7-D0	21-28	24-31	21-28	24-31	Three-State Data Outputs, LSB = D0
CLKIN	29	32	29	32	Clock Input, TTL/CMOS compatible
HBEN	30	33	30	33	High-Byte Enable Input
$\overline{RD}$	31	35	31	35	$\overline{READ}$ Input
$\overline{WR}$	32	36	32	36	$\overline{WRITE}$ Input (MODE = 1 or Open) $\overline{READY}$ Output (MODE = 0)
$\overline{CS}$	33	37	33	37	$\overline{CHIP\text{-}SELECT}$ Input
$\overline{BUSY}$	34	38	34	38	$\overline{BUSY}$ Output
DIFF	35	39	35	39	Single-Ended Mode: DIFF = 0, Differential Mode: DIFF = 1
BIP	36	40	36	40	Unipolar Mode: BIP = 0, Bipolar Mode: BIP = 1
A0-A2	37-39	41-43	37-39	41-43	Multiplexer Channel Address Input: A2 = MSB, A0 = LSB
V_{DD}	40	44	40	44	Positive Supply: +5V Input (substrate connected to V_{DD})
N.C.		1,12, 23,34		1,12, 23,34	No Connect. No internal connection. Leave pin open or connect to AGND.

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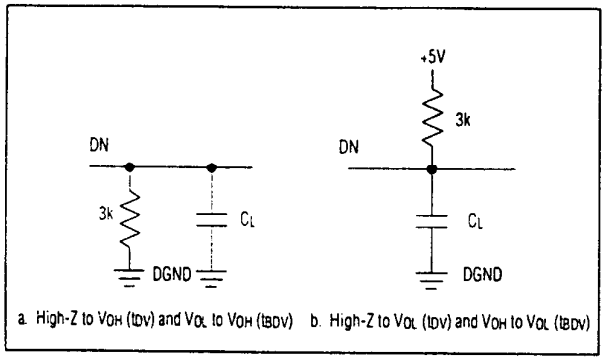


Figure 1. Load Circuits for Access Time

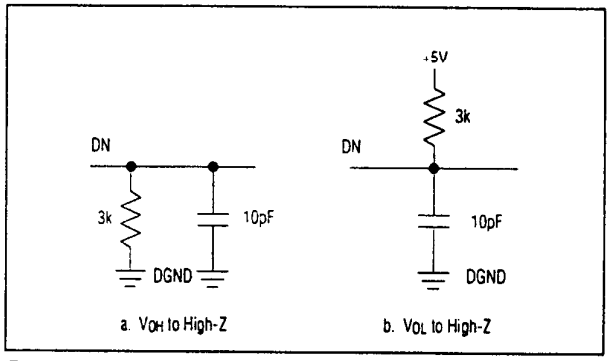


Figure 2. Load Circuits for Bus-Relinquish Time

A/D Converter Operation

The MAX180/MAX181 use successive approximation and input track-and-hold (T/H) circuitry to convert an analog signal to a series of 12-bit digital output codes. The control logic interfaces easily to uPs, requiring only a few passive components for most applications. The T/H does not require an external capacitor. Figure 3 shows the MAX180 typical operating circuit.

Starting a Conversion

Regardless of the mode or interface selected, the following sequence occurs once conversion is started:

1. The data inputs that configure the data-acquisition system (DAS) latch, and the interface signals the µP that a conversion has started.
2. The mux directs the selected input signal to the T/H input.
3. A fixed time delay allows the T/H to acquire the signal. In all modes except asynchronous hold, this delay is 3 clock cycles. In asynchronous hold, the µP controls this delay.
4. The T/H switches to hold mode. The T/H output delivers a stable, single-ended sample of the input signal to the A/D input.
5. The successive approximation cycle begins. The ADC tests and sets each of the 12 bits in turn, from most to least significant. Bit decisions occur on the CLKIN falling edges, for a total of 12 clock cycles.
6. Output data is latched by the output registers, and the interface signals the µP that conversion is complete and data is available.

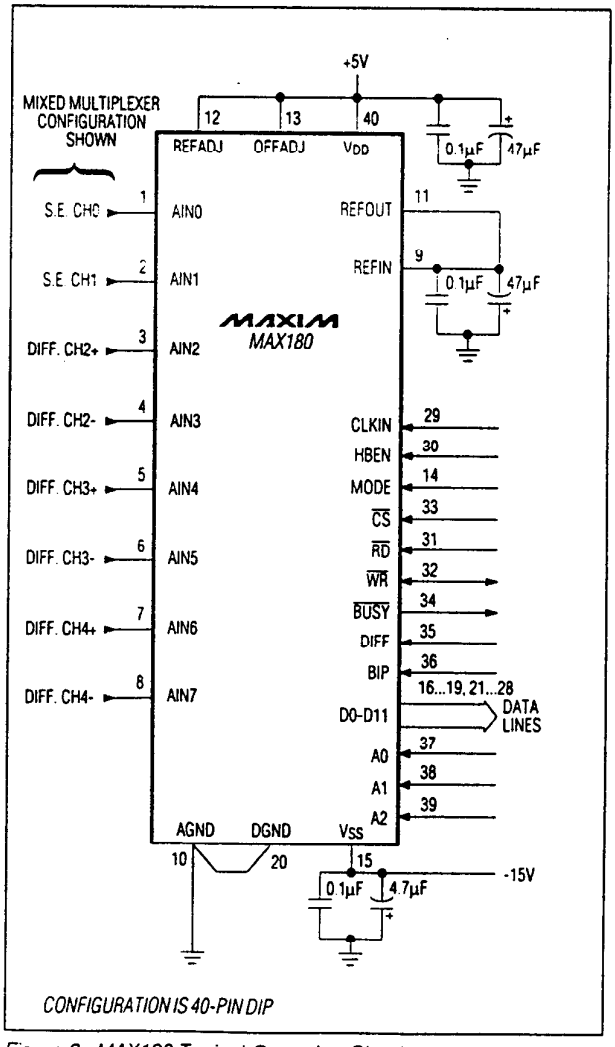


Figure 3. MAX180 Typical Operating Circuit

Analog Input - Track-and-Hold

Figure 4 shows the equivalent input circuit, illustrating the sampling architecture of the ADC's analog comparator. The input capacitance acts as the hold capacitor and is charged by the input signal with every A/D conversion. The capacitance is charged through an internal 1kΩ resistor in series with the input. Note: Figure 4's switches represents both the mux and hold switches.

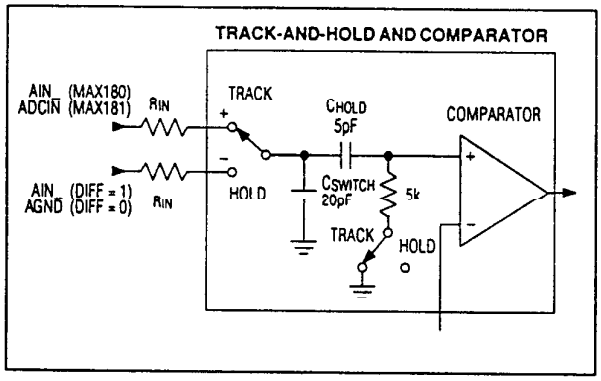


Figure 4. Equivalent Input Circuit

When in single-ended input mode and between conversions ($\overline{BUSY}$ = High), the selected analog input is connected to the hold capacitor (track mode). When a conversion starts, CHOLD disconnects from the + T/H input, thus sampling the input (see "Digital Interface" section for percise T/H timing). When the switch closes at conversion end, CHOLD reconnects to the input and charges to the input signal. The loading effect of the analog inputs on the signal is such that a high-speed input buffer is usually NOT needed because the ADC disconnects from the input during the actual conversion.

The previous explanation applies for the differential input mode if "input" is replaced by AIN+ and "analog ground" is replaced by AIN-. In the differential input mode, A0-A2 select the input channel pairs (Table 1). Only the signal side of the input channel is held by the T/H; the return side must remain stable within ±0.5LSB (±0.1LSB for best results) during the conversion. For example, a common-mode signal of 0.33Vp-p at 60Hz results in a maximum error of 0.5LSB.

The T/H starts tracking when the ADC is deselected ($\overline{BUSY}$ = High). Hold mode begins 3 clock cycles after a conversion is initiated in all but the Asynchronous Hold Mode. Variation in hold-mode delay from one conversion to the next (aperture jitter) is less than 100ps. Figures 7-11 detail the T/H and interface timing for the various interface modes.

The time required for the T/H to acquire an input signal is a function of how quickly the input capacitance is charged. If the input source impedance is high, the acquisition time lengthens and more time must be allowed between conversions. Acquisition time is calculated by:

$$t_{ACQ} = 10(R_S + R_{IN})20pF \text{ (but never less than } 1.875\mu s)$$

where R_{IN} = 1kΩ, and R_S = source impedance of the input signal.

Input Bandwidth

The A/D's input tracking circuitry is excellent for tracking large signals and wide bandwidths and does not exhibit the slew-rate limitations of many other ADC T/Hs. The MAX180/MAX181 T/H's full-power bandwidth is typically 6MHz; this allows the measurement of periodic signals with bandwidths exceeding the ADC's sample rate (100kHz) using under-sampling techniques. Important note: If under-sampling is used to measure high-frequency signals, take special care to avoid aliasing errors. Without adequate input filtering, high-frequency noise could be aliased into the measurement band.

Reference

The MAX180/MAX181 operate with either the internal reference or an external -5V reference. In both cases, REFIN must be bypassed to AGND with a 47µF electrolytic capacitor in parallel with a 0.1µF ceramic capacitor to minimize noise and maintain a low impedance at high frequencies. REFIN is connected directly to the internal DAC, and the current load varies between 0mA and 1mA during conversion.

Internal Reference

The internal reference is buffered through an amplifier whose output connects to REFOUT. To operate the MAX180/MAX181 with the internal reference, connect REFIN to REFOUT. Do not connect a resistor between the bypass capacitors and REFIN. The reference buffer amplifier can sink 5mA for external loads. Adjust the reference output at REFADJ (Figure 14).

External Reference

With a -5V external reference, bypass REFIN to AGND with a 47µF electrolytic capacitor in parallel with a 0.1µF ceramic capacitor. The reference source impedance must be less than 0.2Ω and must be able to sink the internal DAC load of 1mA. Connect REFOUT to VSS and REFADJ to VDD to prevent noise. If REFIN is driven above AGND during power sequencing, latchup can occur. Connect a Schottky clamp diode (IN5817) to prevent REFIN from substantially exceeding AGND.

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Table 1. Address vs. Channel Selection (see Figure 4)

	A2	A1	A0	$\overline{SE}$/DIFF	AIN0	AIN1	AIN2	AIN3	AIN4	AIN5	AIN6	AIN7	COM
MAX180/MAX181	0	0	0	0	+								−
MAX180/MAX181	0	0	1	0		+							−
MAX180/MAX181	0	1	0	0			+						−
MAX180/MAX181	0	1	1	0				+					−
MAX180/MAX181	1	0	0	0					+				−
MAX180/MAX181	1	0	1	0						+			−
MAX180	1	1	0	0							+		−
MAX181	1	1	0	0		MUXOUT CONNECTED TO AGND							+, −
MAX180	1	1	1	0								+	−
MAX181	1	1	1	0		CH 0-5, AND MUXOUT ARE OPEN							−
MAX180/MAX181	0	0	0	1	+	−							
MAX180/MAX181	0	0	1	1	−	+							
MAX180/MAX181	0	1	0	1			+	−					
MAX180/MAX181	0	1	1	1			−	+					
MAX180/MAX181	1	0	0	1					+	−			
MAX180/MAX181	1	0	1	1					−	+			
MAX180	1	1	0	1							+	−	
MAX180	1	1	1	1							−	+	
MAX181	1	1	0	1		MUXOUT CONNECTED TO AGND							+, −
MAX181	1	1	1	1		CH 0-5, AND MUXOUT ARE OPEN							−

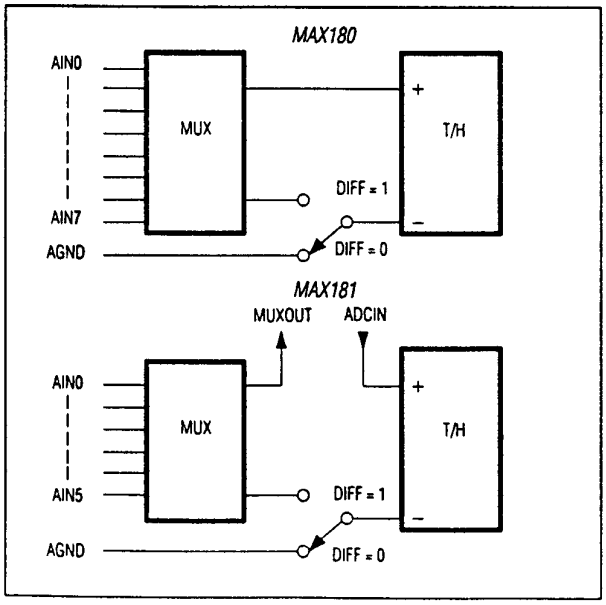


Figure 5. Multiplexer channel configuration

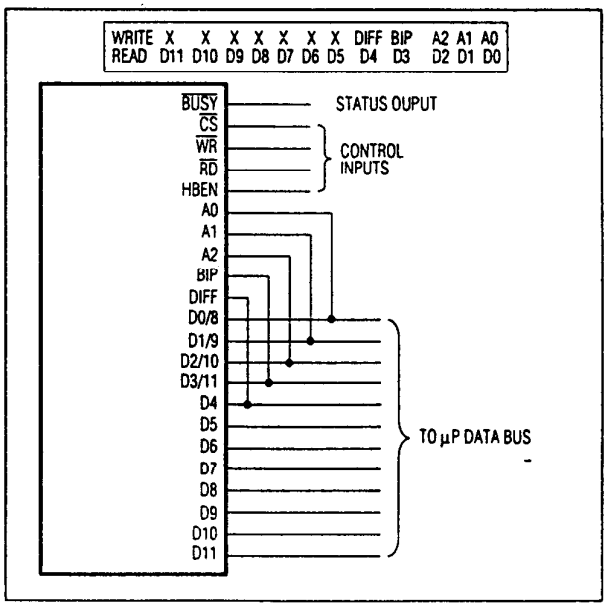


Figure 6. Input/Output Port Mode (12-Bit-Wide Data Bus Shown)

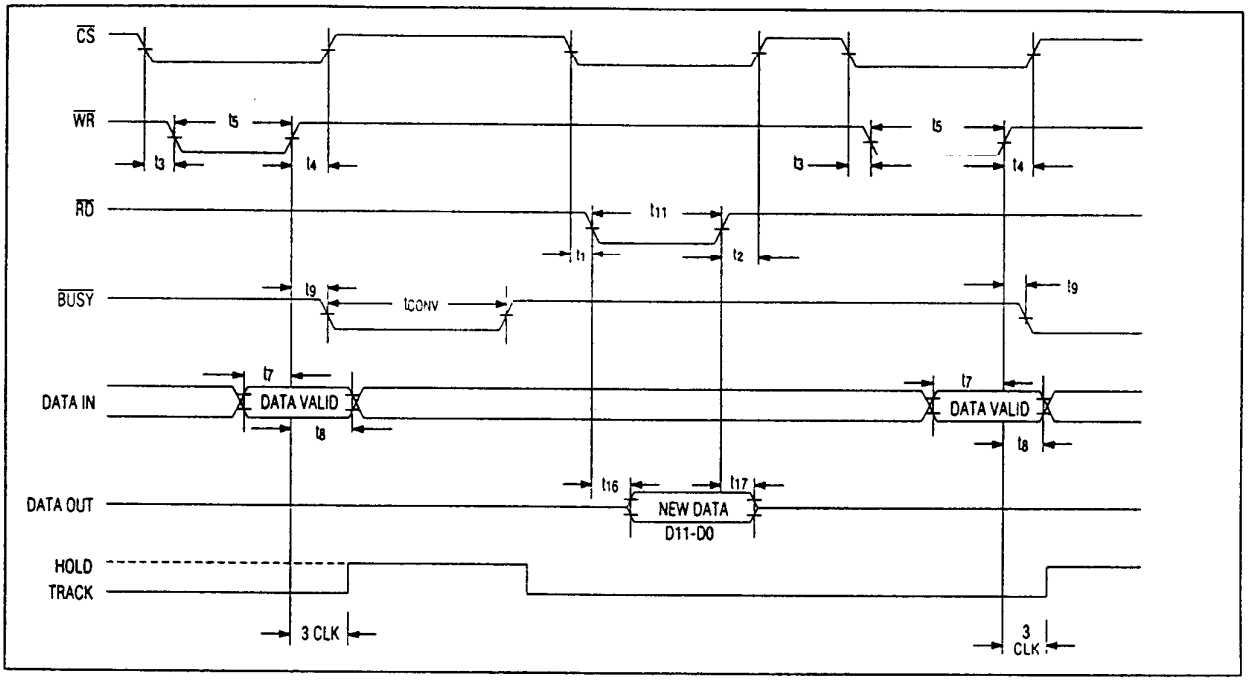


Figure 7a. Input/Output Port-Mode timing, parallel read (MODE = 1, HBEN = 0).

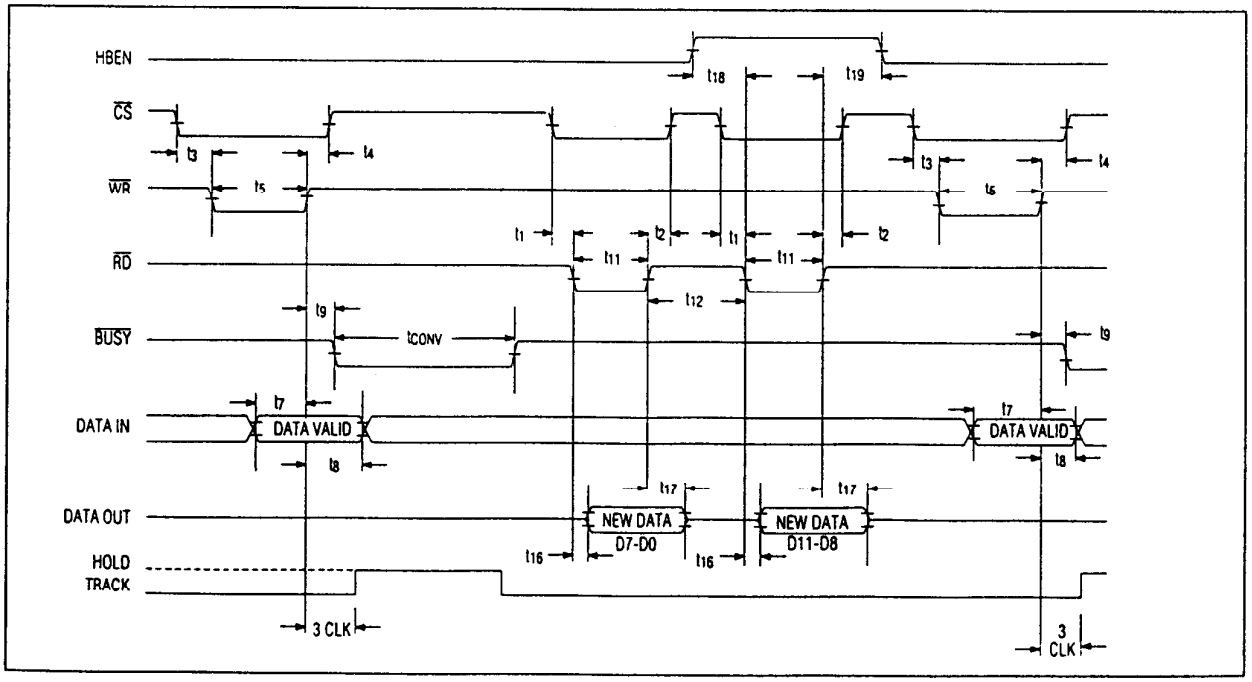


Figure 7b. Input/Output Port-Mode timing, two-byte read (MODE = 1).

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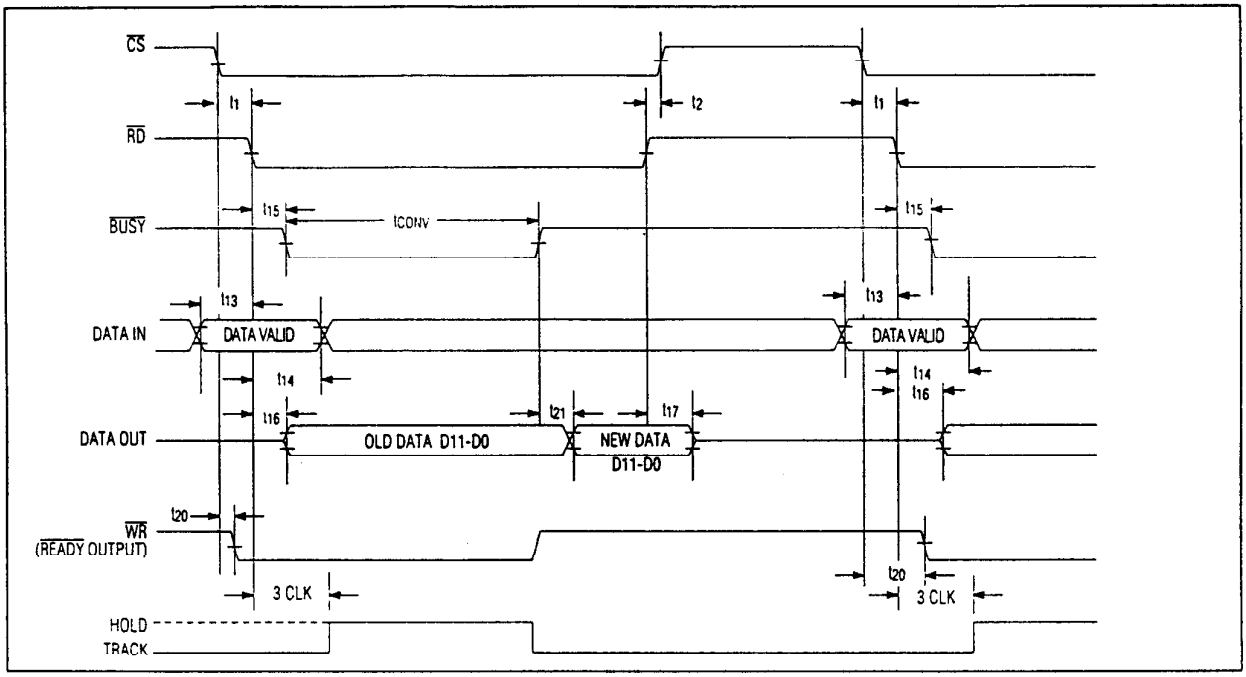


Figure 8a. Slow Memory Mode timing, parallel read (MODE = 0, HBEN = 0).

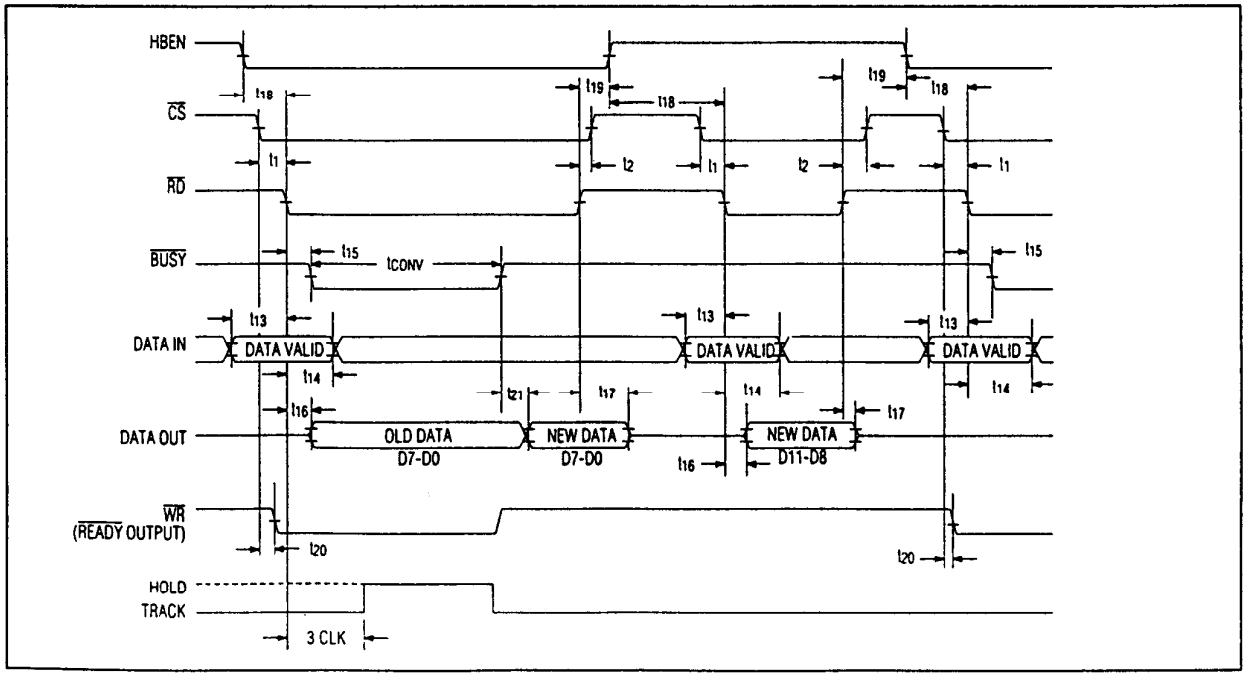


Figure 8b. Slow Memory Mode timing, two-byte read (MODE = 0).

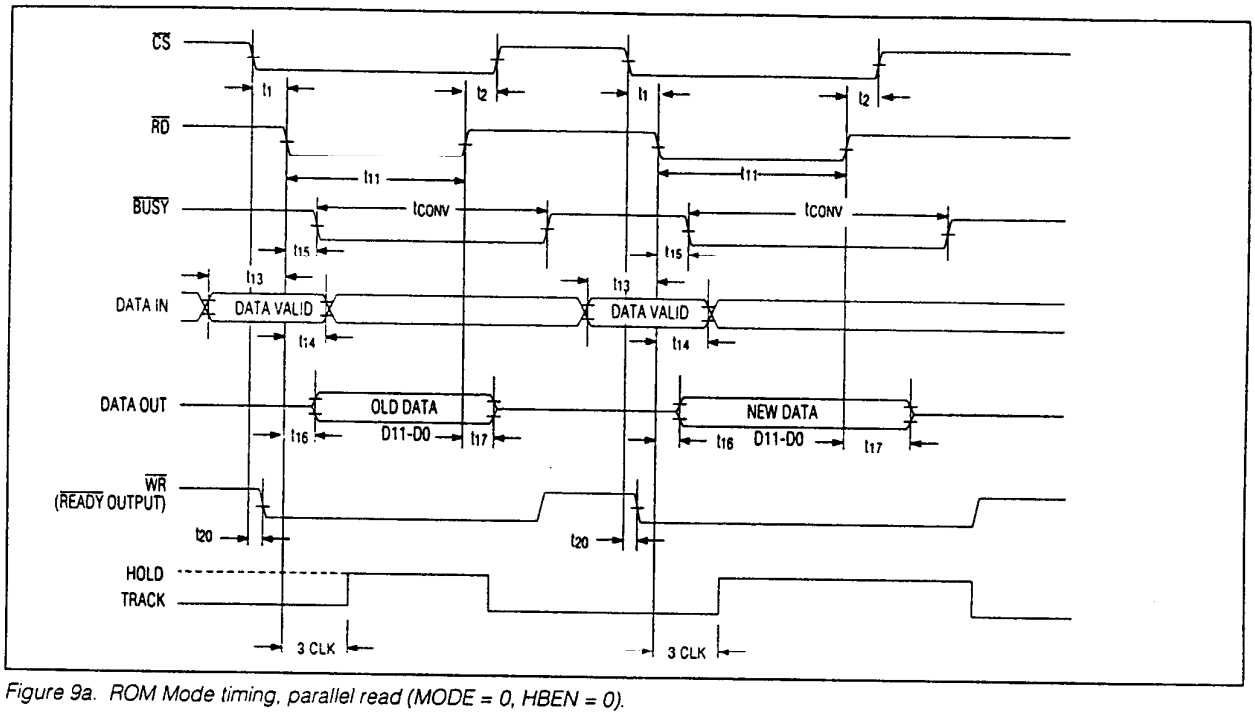


Figure 9a. ROM Mode timing, parallel read (MODE = 0, HBEN = 0).

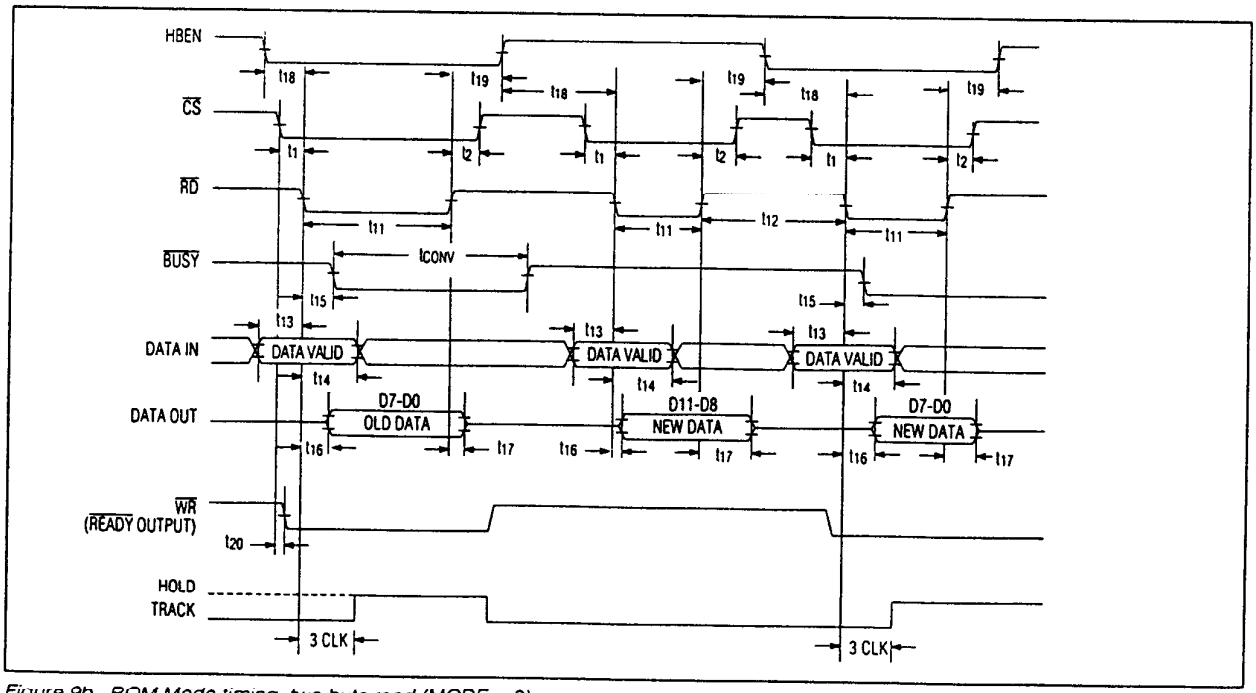


Figure 9b. ROM Mode timing, two-byte read (MODE = 0).

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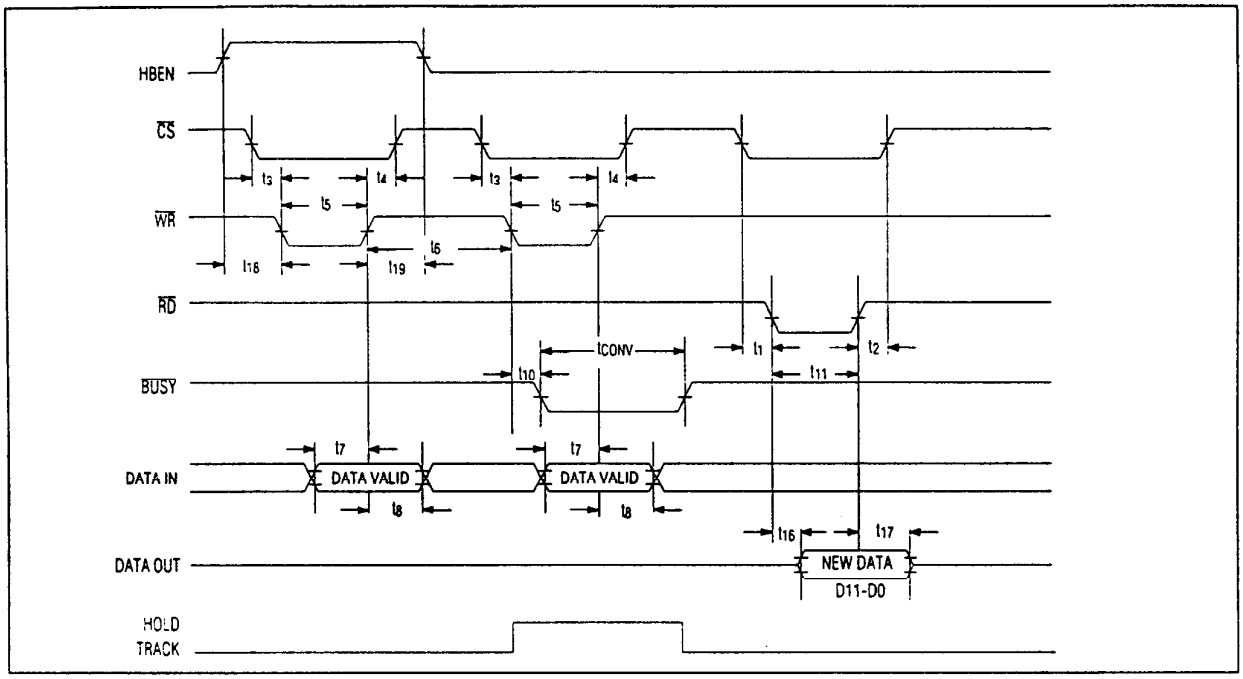


Figure 10a. Asynchronous Hold Mode timing, parallel read (MODE = open circuit)

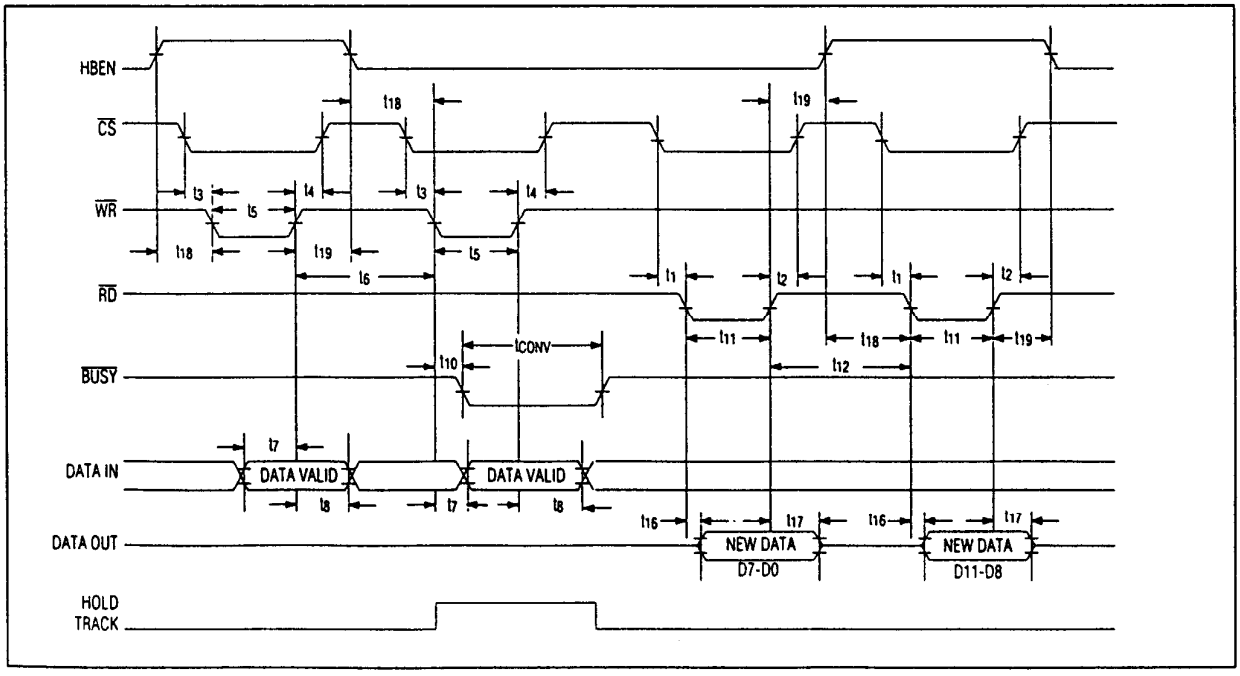


Figure 10b. Asynchronous Hold Mode timing, two-byte read (MODE = open circuit)

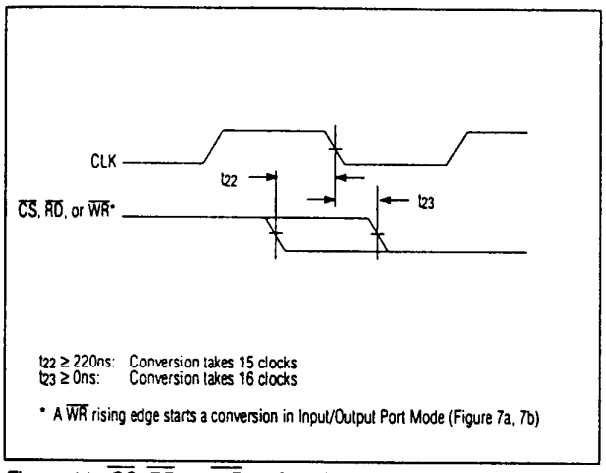


Figure 11. $\overline{CS}$, $\overline{RD}$, or $\overline{WR}$ to CLK Setup and Hold Time for Synchronous Operation

Digital Interface

Input/Output Port Mode (MODE = 1)

In this mode, data inputs and outputs are usually connected together (Figure 6), and the µP writes the configuration data to the DAS internal register with a write instruction (Figure 7). This starts a conversion, as indicated by the high-to-low transition of $\overline{BUSY}$. The mux connects the selected input channel to the T/H, which acquires the signal during the first 3 clock cycles. On the falling edge of the 3rd clock, the T/H switches to hold mode, and the A/D conversion starts. 15 clock cycles after $\overline{WR}$ goes high, $\overline{BUSY}$ goes high, and the conversion result latches into three-state output buffers. The µP can then access the conversion result with a read instruction. For 16-bit bus operation, HBEN = 0, and the 12-bit result is read directly. For 8-bit bus operation, HBEN = 0 during the conversion, and the read instruction returns the 8 LSBs. A second read with HBEN = 1 returns the 4 MSBs in the low nibble. Note: In any mode, HBEN = 1 disables conversion start.

The DAS internal register is 5 bits wide: 3 bits for the analog-channel address, 1 bit for single-ended/differential mux operation, and 1 bit for unipolar/bipolar A/D operation.

Slow Memory Mode (MODE = 0)

The DAS appears to the µP as memory or as a slow peripheral in memory mode. The 5 configuration bits can be preset by an external data latch, a decoded device address, or any external selection logic. A read instruction initiates a conversion as shown in Figure 8. In this mode, the $\overline{WR}$ input functions as the $\overline{RDY}$ output and goes low when $\overline{CS}$ goes low. $\overline{BUSY}$ goes low after $\overline{RD}$ goes low, indicating the beginning of a signal acquisition cycle, and can be used to place the µP into a wait state. When the conversion is complete, $\overline{BUSY}$ releases the µP from its wait state. The µP can then access the conversion result with a read instruction. For 16-bit bus operation, HBEN = 0, and the 12-bit result is read directly. For 8-bit bus operation, HBEN = 0 during the conversion, and the read instruction returns the 8 LSBs. A second read with HBEN = 1 returns the 4 MSBs in the low nibble. Note: In any mode, HBEN = 1 disables conversion start.

ROM Mode, Parallel Read (MODE = 0)

ROM mode avoids using µP wait states. A conversion starts with a read instruction, and the 12 data bits from the previous conversion appear at D11-D0. The data from the first read in a sequence is often disregarded when ROM mode is used. A second read accesses the results of the first conversion and starts a new conversion. The time between successive reads must be longer than the conversion time of the MAX180/MAX181 (Figure 9a, 16-bit bus).

ROM Mode, 2-Byte Read (MODE = 0)

As in memory mode, only D7-D0 are used for a 2-byte read. A conversion starts with a read instruction when HBEN is low. At this point, the data outputs contain the 8 LSBs from the previous conversion. Two more read operations are needed to access the conversion result. The first, with HBEN high, accesses the 4 MSBs with 4 leading zeros. The second read, with HBEN low, outputs the 8 LSBs and starts a new conversion. Figure 9b (8-bit bus) details this mode.

Asynchronous Hold Mode (MODE = Open)

Asynchronous hold mode is helpful when a precise or repeatable sample timing is required. Asynchronous hold is very similar to the I/O port mode, except two write instructions are required. The first write, with HBEN = 1, configures the MAX180/MAX181 and connects the selected channel to the T/H input; the second write, with HBEN = 0, places the T/H into hold and starts the conversion. In other words, the three-clock cycle delay for T/H acquisition can be changed by controlling when the second write instruction occurs. The falling edge of the second $\overline{WR}$ pulse places the T/H into hold (Figure 10).

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External Clock

The range for the external clock duty cycle is between 20% and 80%. A precise square wave is not required.

Clock and Control Synchronization

For best analog performance, the MAX180/MAX181 clock should be synchronized to the $\overline{RD}$, $\overline{WR}$, and $\overline{CS}$ inputs (Figure 11) with at least 100ns separating convert start from the nearest clock edge. This synchronization ensures that transitions at CLKIN are not coupled to the analog input and sampled by the T/H. The magnitude of this feedthrough is only a few millivolts. If CLKIN and convert start ($\overline{CS}$, $\overline{WR}$ and $\overline{RD}$) are asynchronous, frequency components caused by mixing of the clock and convert signals can increase the apparent input noise.

When the clock and convert signals are synchronized, small end-point errors (offset and full-scale) are the most that can be generated by clock feedthrough, but even these errors are eliminated by ensuring that the start of a conversion ($\overline{RD}$ or $\overline{WR}$ and $\overline{CS}$ falling edge) does not occur within 100ns of a clock transition (Figure 11).

Output Data Format

The 12 data bits can be output either in full parallel or as two 8-bit bytes. Table 2 shows the data-bus output format. To obtain parallel output for 16-bit µPs, HBEN is tied low. Note: The output data, D11-D0, is right-justified (i.e. D0, the LSB, is the right-most bit in the 16-bit word).

A two-byte read makes use of outputs D7-D0. Byte selection is controlled by HBEN, which multiplexes the data outputs. When HBEN is low, the lower 8 bits appear at the data outputs. When HBEN is high, the upper 4 bits appear at D0-D3 with the leading 4 bits low in locations D4-D7. Note: The 4 MSBs always appear at D11-D8 when the outputs are enabled, regardless of the state of HBEN.

Application Hints

Initialization After Power-Up

In some applications, power is removed from the ADC during periods of inactivity to conserve power. This is increasingly common in battery-powered systems. To initialize the MAX180/MAX181 at power-up, execute a read operation with HBEN low, ignoring the data outputs.

Minimizing System-Induced Noise

The MAX180/MAX181 are insensitive to most noise sources, especially when the layout, bypass, and grounding recommendations are followed. The following practices should also be considered:

1. Minimize digital activity during conversion, especially activity that is asynchronous with the MAX180/MAX181 clock.
2. Avoid data-bus activity within ±20ns of the CLKIN falling edge.

If the data bus connected to the ADC is active during a conversion, coupling from the data pins to the ADC comparator can cause errors. Using slow-memory mode avoids this problem by placing the µP in a wait state during the conversion. In ROM mode, the bus should be isolated from the ADC using three-state drivers if the data bus is active during the conversion.

In ROM mode, the ADC generates considerable digital noise when $\overline{RD}$ or $\overline{CS}$ go high and the output data drivers are disabled after conversion start. This noise can affect the ADC comparator and cause large errors if it coincides with the SAR latching a comparator decision. To prevent this, $\overline{RD}$ and $\overline{CS}$ should be active for less than one clock cycle. If this is not possible, $\overline{RD}$ or $\overline{CS}$ should go high on a rising edge of CLKIN because the comparator output is latched on the falling edge of CLKIN.

Table 2. Data-Bus Output, $\overline{CS}$ & $\overline{RD}$ = LOW

DIP Pin #	Pin 16	Pin 17	Pin 18	Pin 19	Pin 21	Pin 22	Pin 23	Pin 24	Pin 25	Pin 26	Pin 27	Pin 28
Pin Label*	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
HBEN = LOW**	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
HBEN = HIGH**	D11	D10	D9	D8	LOW	LOW	LOW	LOW	D11	D10	D9	D8

Note: * D11–D0 are the ADC data output pin names.
** D11–D0 are the 12-bit conversion results. D11 is the MSB.

Layout, Grounding, Bypassing

Use printed circuit boards for best system performance; wire-wrap boards are not recommended. The board layout should ensure that digital- and analog-signal lines are separated as much as possible. Do not run analog and digital (especially clock) lines parallel to one another or digital lines underneath the ADC package.

Figure 12a shows the recommended system-ground connections. A single-point analog STAR ground should be established at AGND, separate from the logic ground. All other analog grounds and DGND should be connected to this STAR ground, and no other digital system grounds should be connected here. For noise-free operation, the ground return to the power supply from this STAR ground should be low impedance and as short as possible.

The ADC's high-speed comparator is sensitive to high-frequency noise in the V_{DD} and V_{SS} power supplies. These supplies should be bypassed to the analog STAR ground with 0.1µF and 47µF bypass capacitors. Minimize capacitor lead length for best supply noise rejection. If the 5V power supply is very noisy, connect a small (10Ω) resistor to filter the noise (Figure 12b).

Gain and Offset Adjustment

Figure 13 plots the nominal unipolar I/O transfer function of the MAX180/MAX181. Code transitions occur halfway between successive integer LSB values. Output coding for unipolar operation is natural binary with 1LSB = 1.22mV (5V/4096). Figure 14 shows the bipolar-input transfer function, where output coding is twos-complement.

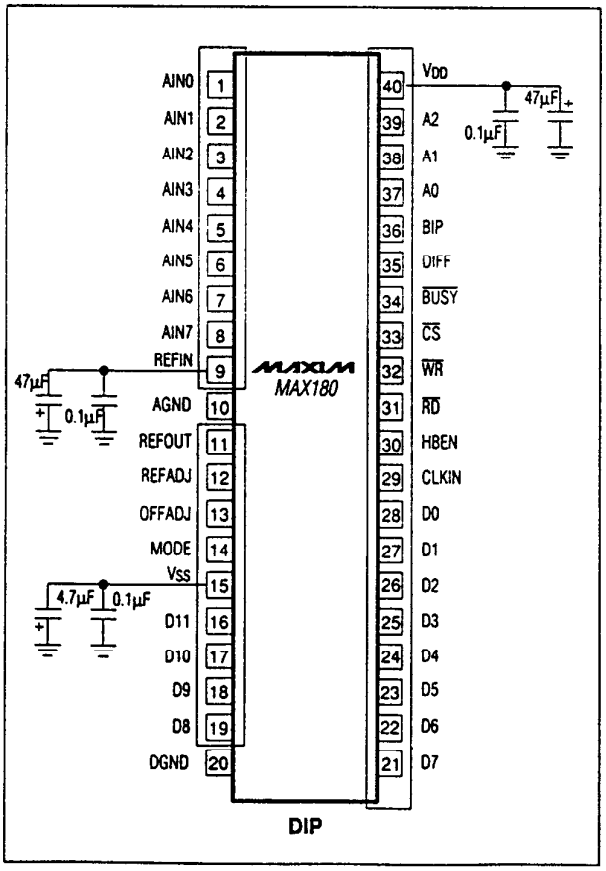


Figure 12a. Recommended Grounding and Ground Plane

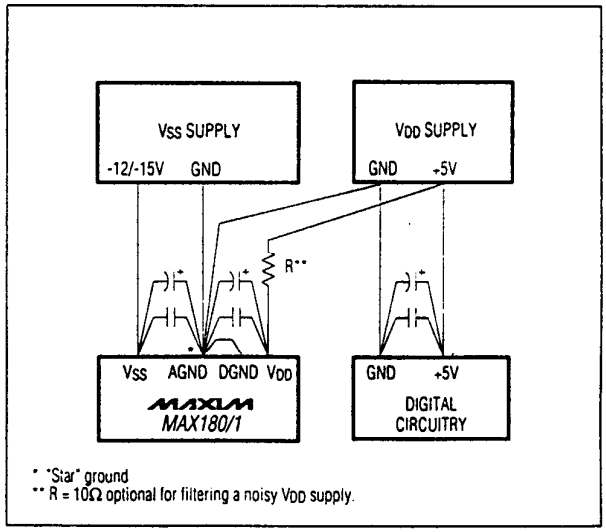


Figure 12b. Power-Supply Grounding

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If offset and gain adjustments are not desired, connect OFFADJ and REFADJ to V_{DD}. Figure 15's circuit provides ±1.2% (±50 LSBs) of adjustment range for gain and ±0.44% (±18LSBs) of adjustment range for offset. This is ideal for applications that require gain (full-scale range) or offset adjustment. If the adjustment inputs are used, bypass to AGND with a 0.1µF capacitor. Offset should be adjusted before gain. For the 0V to 5V input range, apply LSB (0.61mV) to the analog input, and adjust R1 so the digital output code changes between 0000 0000 0000 and 0000 0000 0001. To adjust full scale, apply FS - 1LSB (4.99817V), and adjust R2 until the output code changes between 1111 1111 1110 and 1111 1111 1111. There may be a slight interaction between the adjustments.

To adjust bipolar (±2.5V) offset, apply LSB (0.61mV) to the analog input, and adjust R1 until the output code switches between 0000 0000 0000 and 0000 0000 0001. For full scale, apply FS - 1LSB (2.49817V) to the input, and adjust R2 so the output code switches between 0111 1111 1110 and 0111 1111 1111 (Figure 15). There may be some interaction between these adjustments. If an external reference is used, adjust gain by varying the value of the reference instead of R2.

Dynamic Performance

Wide-bandwidth analog input and 100kHz throughput make the MAX180/MAX181 ideal for wideband-signal processing. To support these and other related applications, fast Fourier transform (FFT) test techniques guarantee the ADC's dynamic frequency response, distortion, and noise at the rated throughput. Specifically, this involves applying a low-distortion sine wave to the ADC input and recording the digital conversion results for a specified time. The data is then analyzed using an FFT algorithm that determines its spectral content. Conversion errors are seen as spectral elements outside of the fundamental input frequency.

ADCs have traditionally been evaluated by specifications such as zero and full-scale error and integral (INL) and differential (DNL) nonlinearity. Such parameters are widely accepted for specifying performance with DC and slowly varying signals, but less useful in signal-processing applications where the ADC's impact on the system transfer function is the main concern. The significance of the various DC parameters does not translate well to the dynamic case, so different tests are required.

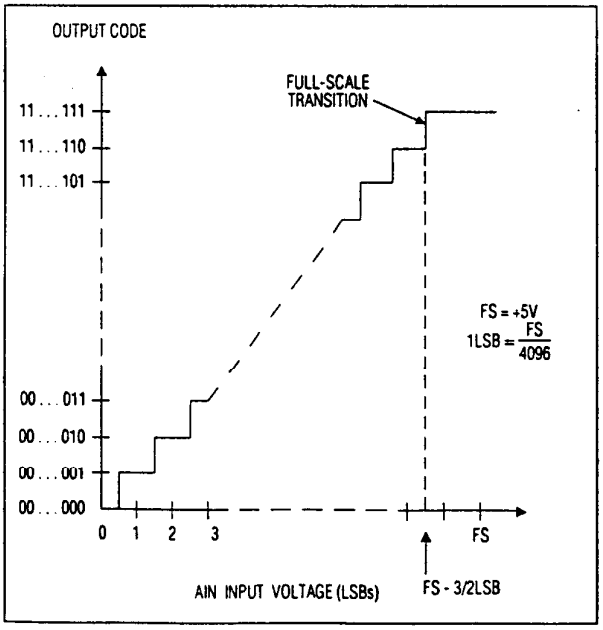


Figure 13. MAX180/MAX181 Unipolar Transfer Function

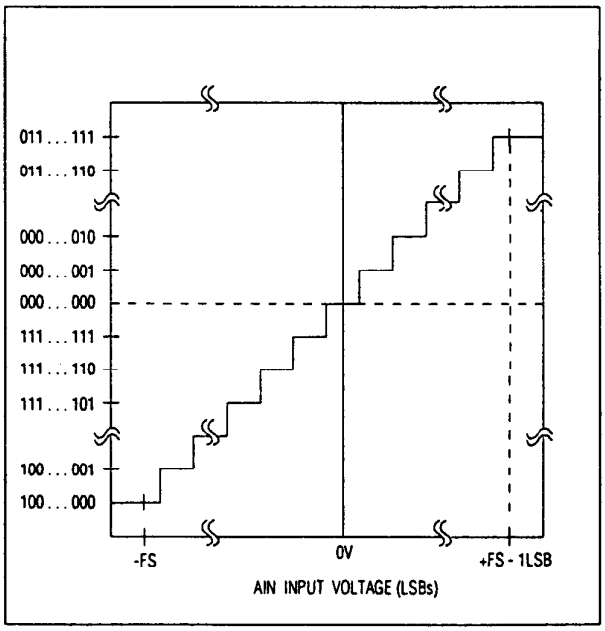


Figure 14. MAX180/MAX181 Bipolar Transfer Function

Signal-to-Noise Ratio and Effective Number of Bits

Signal-to-noise ratio (SNR) is the ratio between the RMS amplitude of the fundamental frequency to the RMS amplitude of all other ADC spectral components, excluding harmonics. The output band is limited to frequencies above DC and below one-half the ADC sample (conversion) rate. This band includes both distortion and noise components. For this reason, the signal-to-noise and distortion ratio (SINAD) is a better measure of the ADC's performance.

The theoretical minimum ADC noise is caused by quantization error and is a direct result of the ADC's resolution:

$$SNR = (6.02N + 1.76)dB$$

where N is the number of bits of resolution. A perfect 12-bit ADC can therefore do no better than 74dB. Figure 16 shows the result of sampling a pure 10kHz sinusoid at a 100kHz rate with the MAX180/MAX181. An output FFT plot shows the relative output amplitude at discrete spectral frequencies (Figure 16).

By transposing the equation that converts resolution to SNR, we can determine the effective resolution (effective number of bits) the ADC provides from the measured SNR: N = (SNR - 1.76)/6.02. Figure 17 shows the effective number of bits as a function of the input frequency for the MAX180/MAX181.

Total Harmonic Distortion

Total harmonic distortion (THD) is the ratio of the RMS sum of all the harmonics (in the frequency band above DC and below one-half the sample rate) to the RMS amplitude of the fundamental frequency. This is expressed as:

$$THD = 20Log\left[\frac{\sqrt{(V_2^2 + V_3^2 + \ldots + V_N^2)}}{V_1}\right]$$

where V_1 is the fundamental RMS amplitude, and V_2 to V_N are the amplitudes of the 2nd through Nth harmonics.

Spurious-Free Dynamic Range

Spurious-free dynamic range is the ratio of the fundamental RMS amplitude to the amplitude of the next largest spectral component (in the frequency band above DC and below one-half the sample rate). Usually this peak occurs at some harmonic of the input frequency. But if

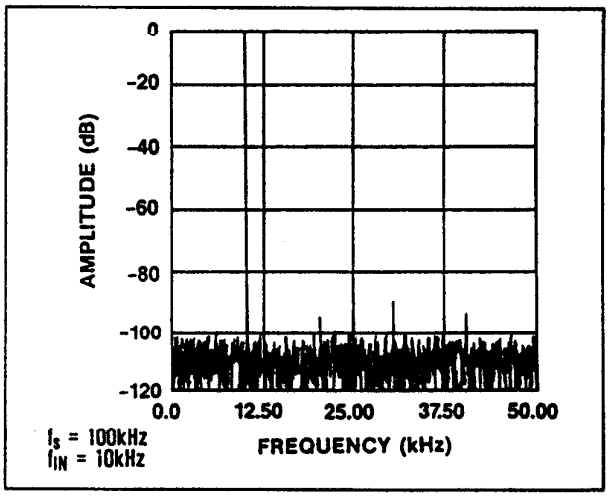


Figure 16. FFT Plot for the MAX180/MAX181

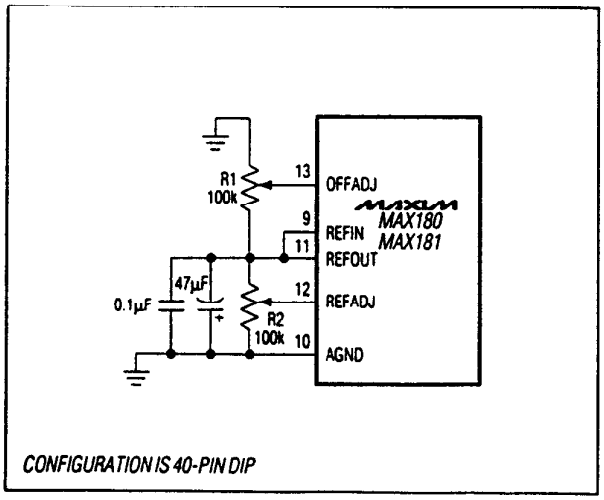


Figure 15. Offset and Gain Adjustment

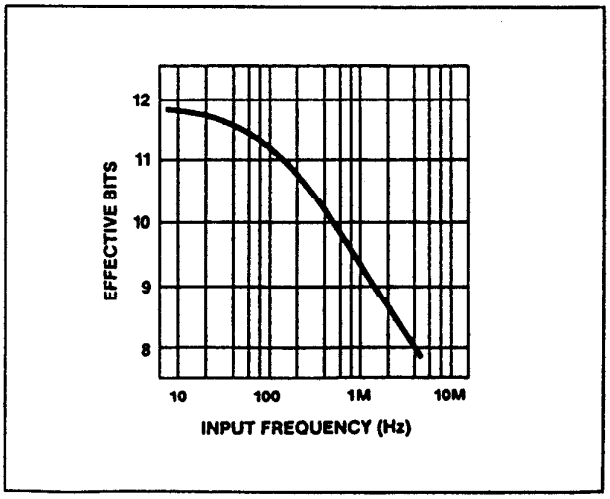


Figure 17. MAX180/MAX181 Effective Bits vs. Input Frequency

Complete, 8-Channel, 12-Bit Data-Acquisition Systems

Typical Applications

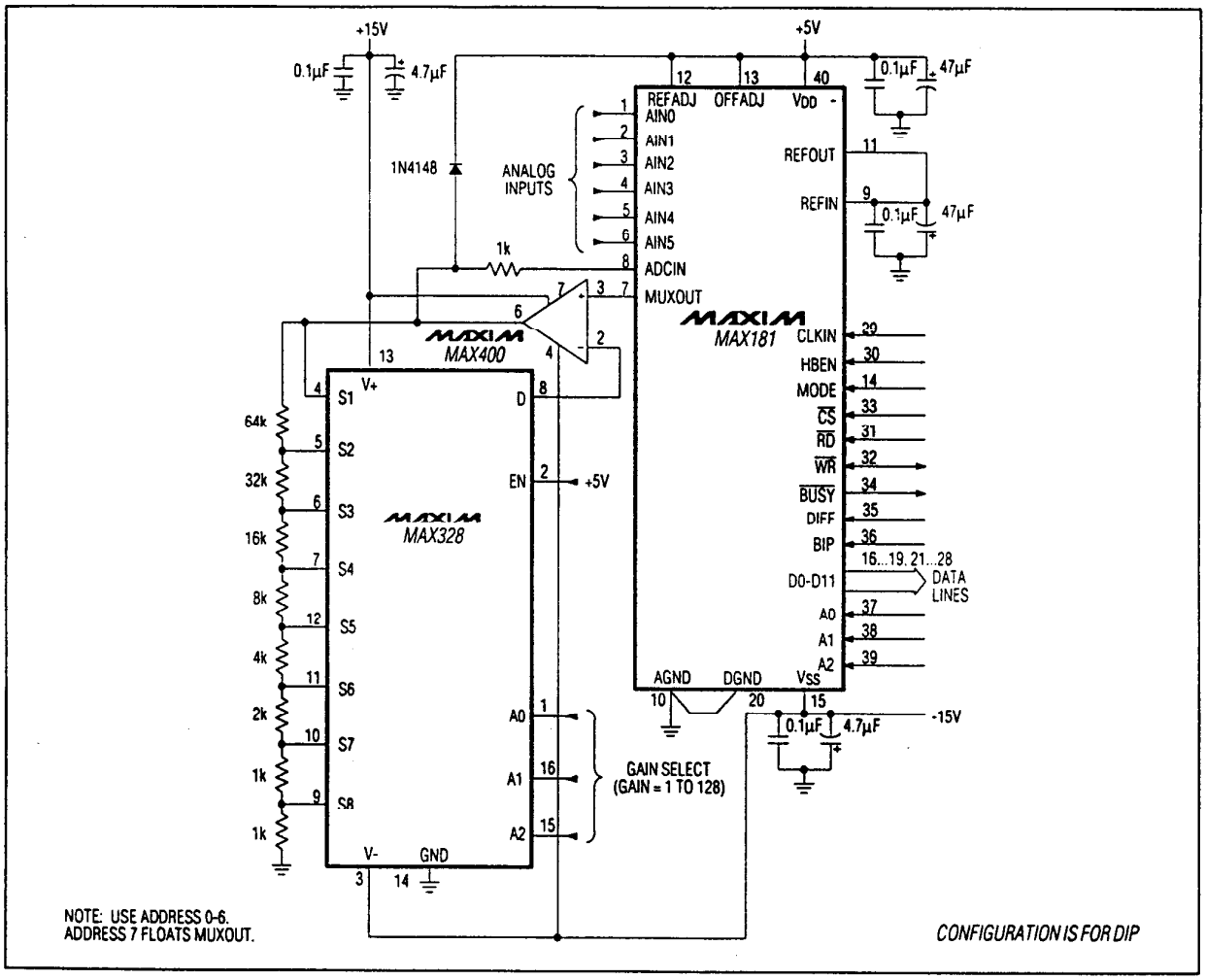


Figure 18a. MAX181 operating as a 6-channel programmable gain ADC. Gains are 1, 2, 4, 8, 16, 32, 64, and 128.

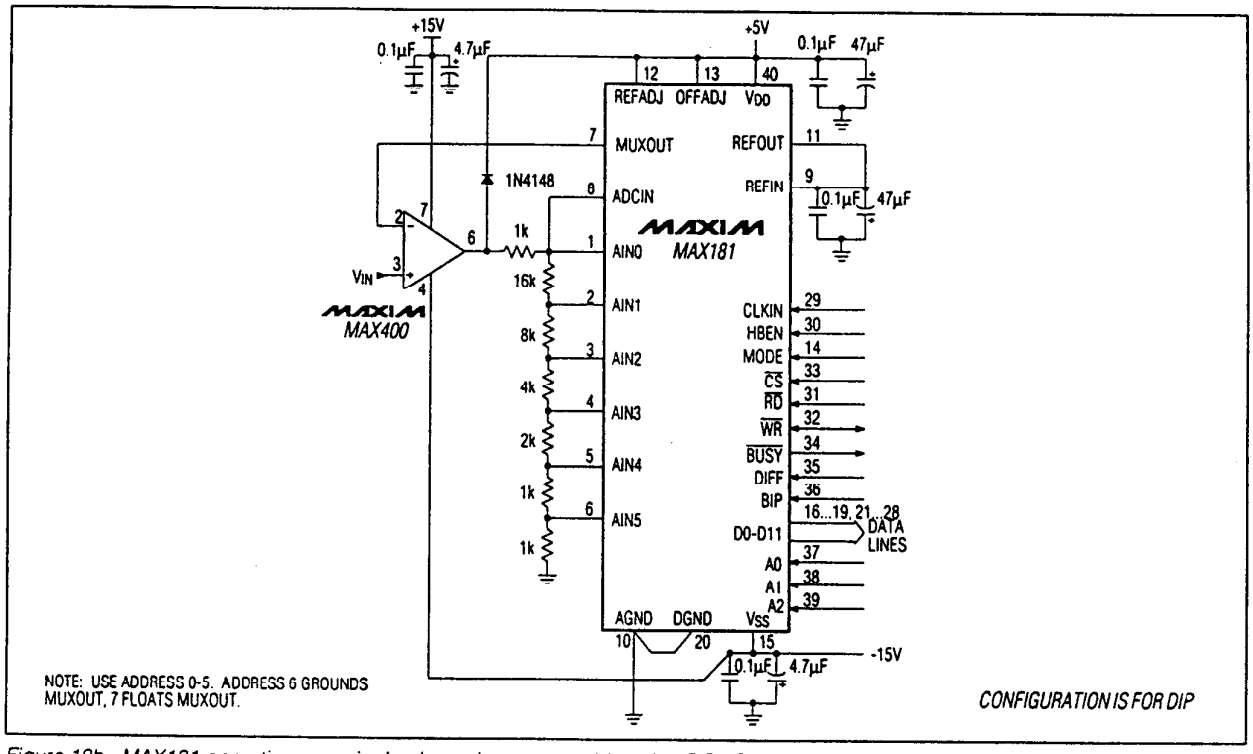
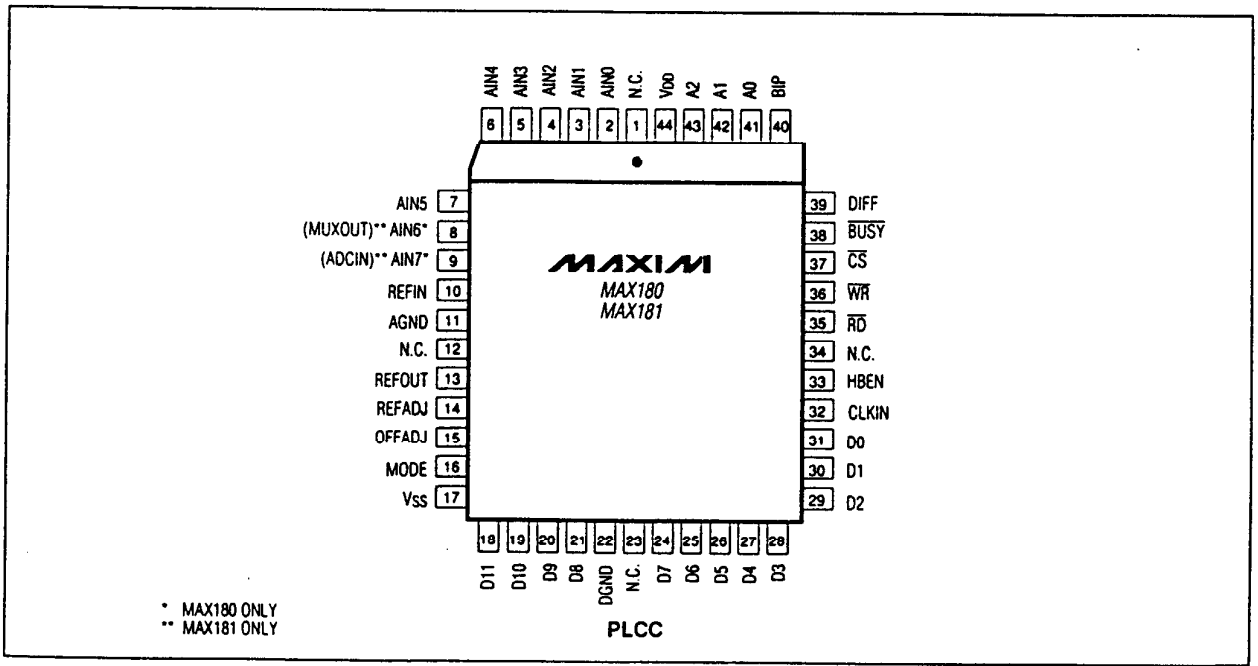


Figure 18b. MAX181 operating as a single-channel programmable gain ADC. Gains are 1, 2, 4, 16, and 32.

Pin Configurations (continued)



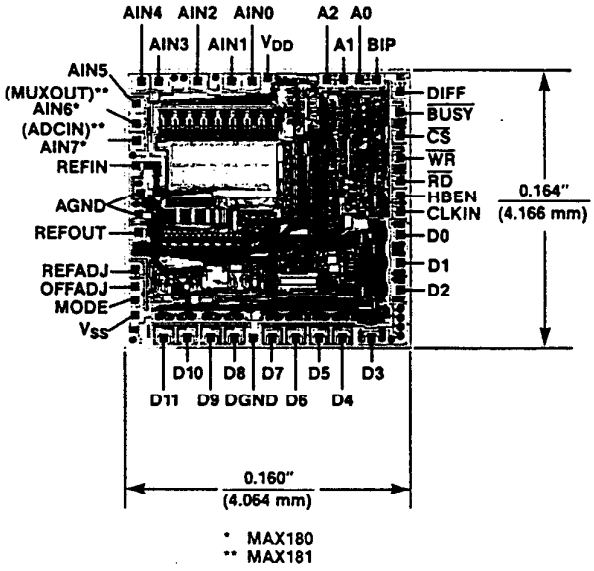
Complete, 8-Channel, 12-Bit Data-Acquisition Systems

Ordering Information (continued)

PART	TEMP. RANGE	PIN-PACKAGE	ERROR (LSBs)
MAX180CCQH	0°C to +70°C	44 PLCC	±1
MAX180CC/D	0°C to +70°C	Dice*	±1
MAX180AEPL	-40°C to +85°C	40 Plastic DIP	±1/2
MAX180BEPL	-40°C to +85°C	40 Plastic DIP	±1
MAX180CEPL	-40°C to +85°C	40 Plastic DIP	±1
MAX180AEQH	-40°C to +85°C	44 PLCC	±1/2
MAX180BEQH	-40°C to +85°C	44 PLCC	±1
MAX180CEQH	-40°C to +85°C	44 PLCC	±1
MAX180AMJL	-55°C to +125°C	40 CERDIP**	±1/2
MAX180BMJL	-55°C to +125°C	40 CERDIP**	±1
MAX180CMJL	-55°C to +125°C	40 CERDIP**	±1
MAX181ACPL	0°C to +70°C	40 Plastic DIP	±1/2
MAX181BCPL	0°C to +70°C	40 Plastic DIP	±1
MAX181CCPL	0°C to +70°C	40 Plastic DIP	±1
MAX181ACQH	0°C to +70°C	44 PLCC	±1/2
MAX181BCQH	0°C to +70°C	44 PLCC	±1
MAX181CCQH	0°C to +70°C	44 PLCC	±1
MAX181CC/D	0°C to +70°C	Dice*	±1
MAX181AEPL	-40°C to +85°C	40 Plastic DIP	±1/2
MAX181BEPL	-40°C to +85°C	40 Plastic DIP	±1
MAX181CEPL	-40°C to +85°C	40 Plastic DIP	±1
MAX181AEQH	-40°C to +85°C	44 PLCC	±1/2
MAX181BEQH	-40°C to +85°C	44 PLCC	±1
MAX181CEQH	-40°C to +85°C	44 PLCC	±1
MAX181AMJL	-55°C to +125°C	40 CERDIP**	±1/2
MAX181BMJL	-55°C to +125°C	40 CERDIP**	±1
MAX181CMJL	-55°C to +125°C	40 CERDIP**	±1

* *Contact factory for dice specifications.*
** *Contact factory for availability and processing to MIL-STD-883.*

Chip Topography



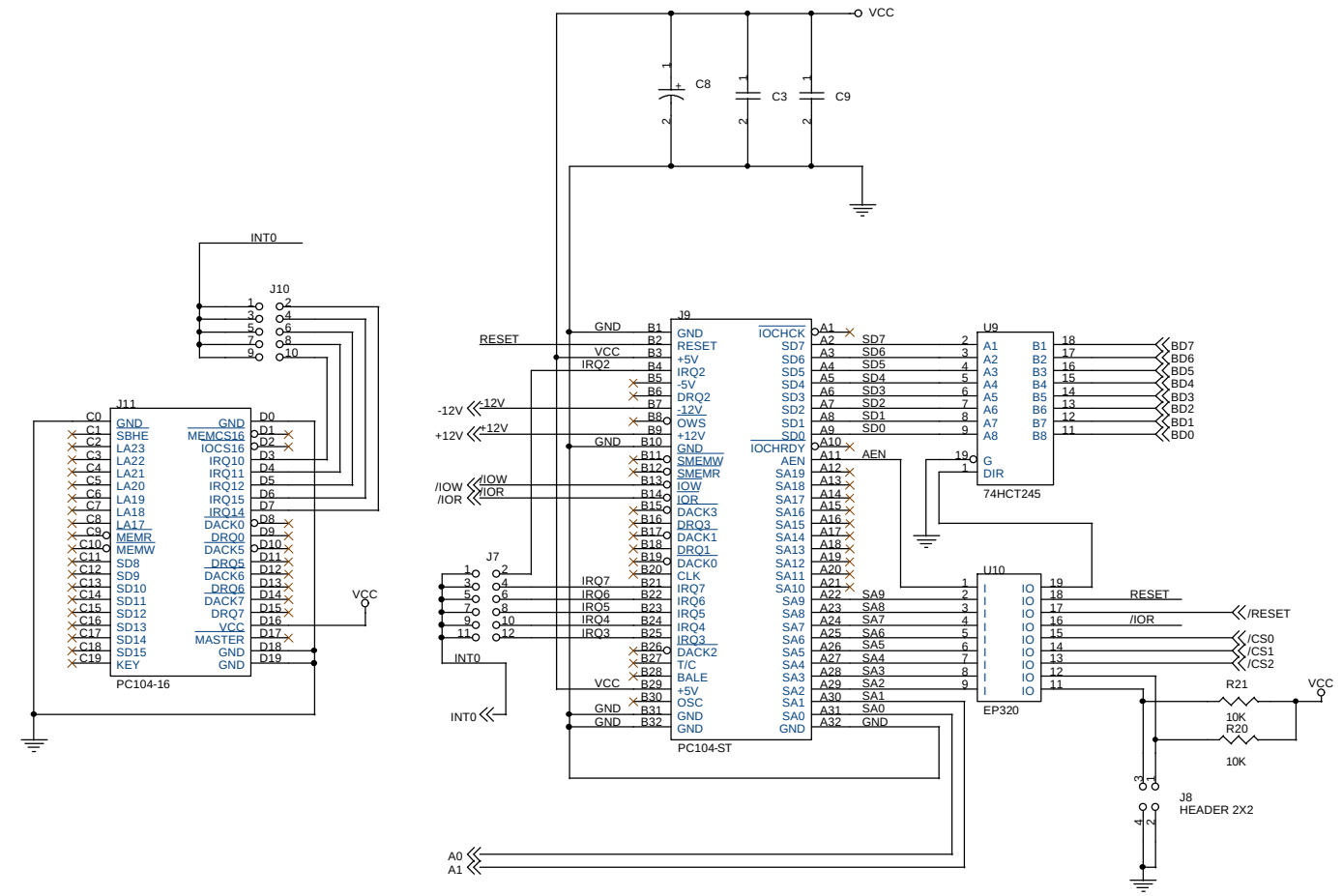
* MAX180
** MAX181

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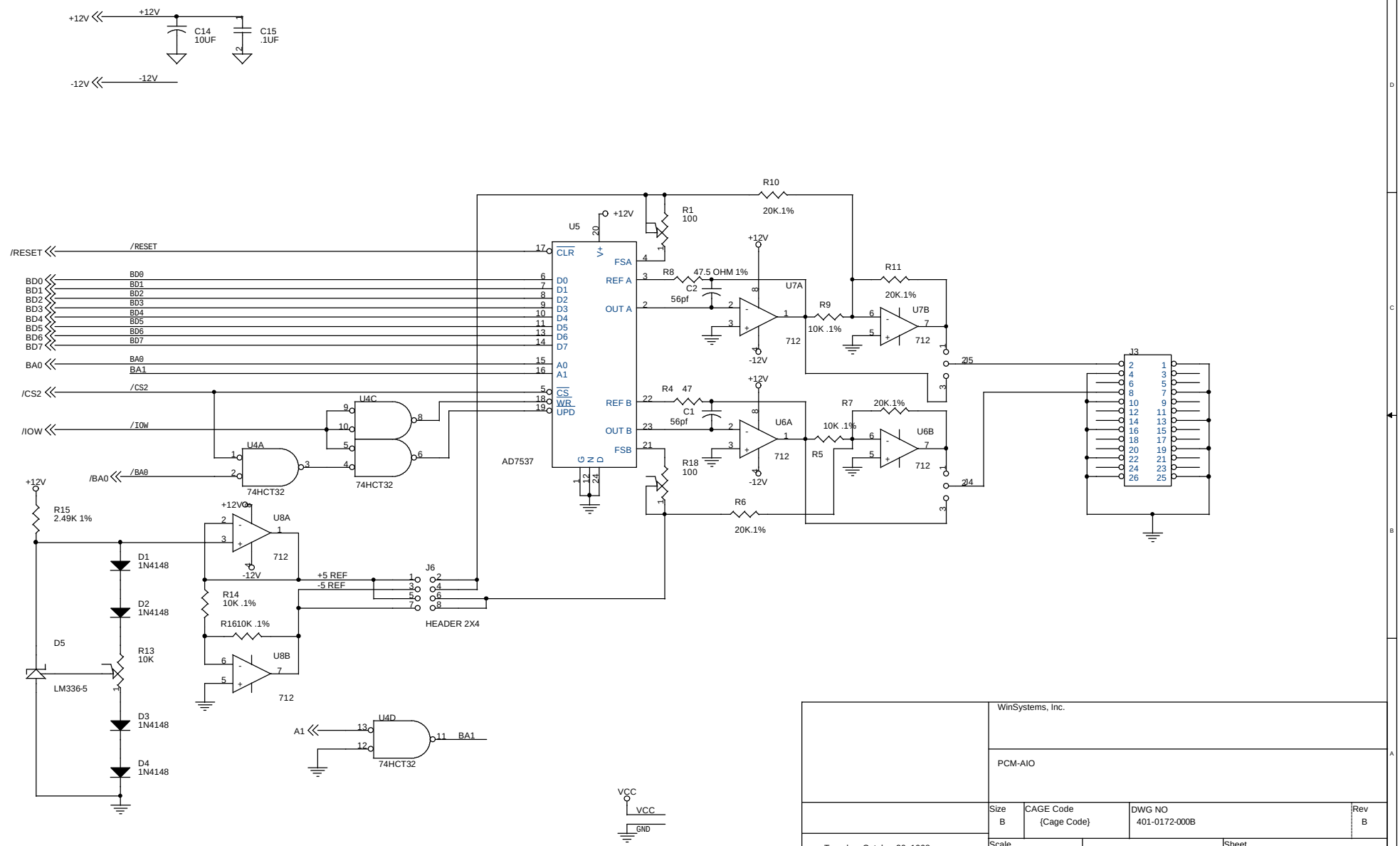
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6 APPENDIX D
PCM-AIO Schematic Diagrams

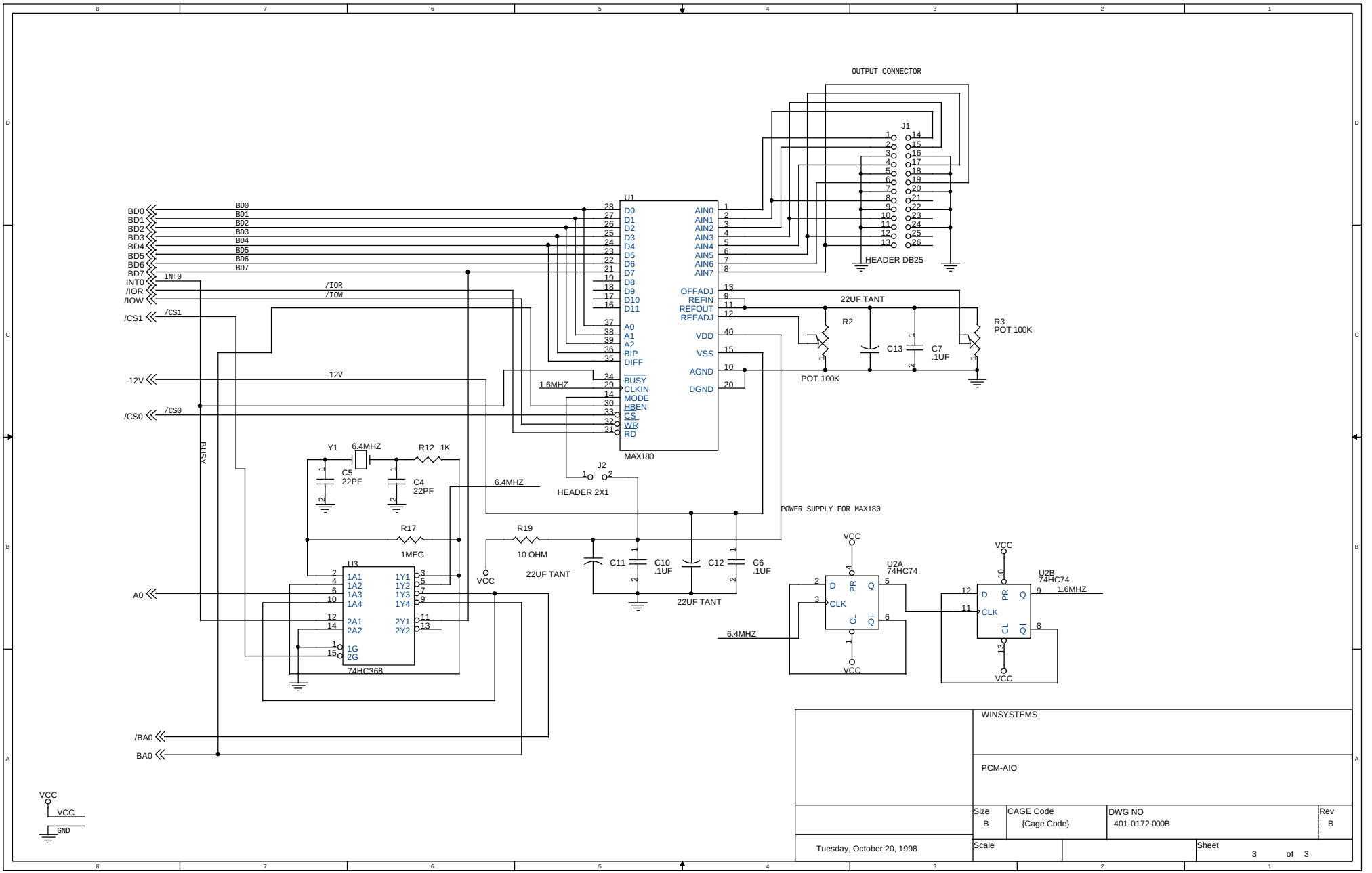
|LINK
|PCMAIO2.SCH
|PCMAIO3.SCH



ECO# 98-29 REV TO B	WINSYSTEMS		
	PCM-AIO		
	Size: B	CAGE Code: {Cage Code}	DWG NO: 401-0172-000B / Rev: B
Tuesday, October 20, 1998	Scale:		Sheet: 1 of 3



	WinSystems, Inc.			
	PCM-AIO			
	Size: B	CAGE Code: {Cage Code}	DWG NO: 401-0172-000B	Rev: B
Tuesday, October 20, 1998	Scale:		Sheet: 2 of 3	


OUTPUT CONNECTOR
J1
HEADER DB25
U1
MAX180
BD0
BD1
BD2
BD3
BD4
BD5
BD6
BD7
INT0
/IOR
/IOW
/CS1
-12V
/CS0
BUSY
1.6MHZ
6.4MHZ
Y1 6.4MHZ
R12 1K
C5 22PF
C4 22PF
J2
HEADER 2X1
R17
1MEG
R19
10 OHM
22UF TANT
C11
C10 .1UF
C12
C6 .1UF
VCC
POWER SUPPLY FOR MAX180
R2
POT 100K
C13
C7 .1UF
R3 POT 100K
U3
74HC368
A0
/BA0
BA0
U2A 74HC74
U2B 74HC74
WINSYSTEMS
PCM-AIO
Size B
CAGE Code {Cage Code}
DWG NO 401-0172-000B
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2. Reason for the return.
3. Invoice number and date of purchase (if available), and original purchase order number.
4. Name, address, telephone and FAX number of the person making the request.
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